

U.S. Patent Application Serial No. **09/939,716**
Amendment filed December 16, 2005
Reply to OA dated July 25, 2005

REMARKS:

Claims 1-21 are currently being examined, of which claims 13, 17, and 18 have been amended herein and claims 19-21 have been newly added herein.

Applicants and Applicants' attorney thank Examiner Leung for the interview courteously granted November 22, 2005. The special attention the Examiner paid to the instant application is noted with appreciation. Items discussed during the interview include the Office Action mailed July 25, 2005.

The Examiner has indicated that claims 13, 17, and 18 set forth allowable subject matter. In particular, the Examiner has objected to claims 13, 17, and 18 as being dependent upon rejected base claims, and has noted that claims 13, 17, and 18 would be allowable if rewritten in independent form including the limitations of the base claims and any intervening claims.

Claims 13, 17, and 18, as amended herein, are intended to correspond to previous claims 13/9/6/5/1, 17/9/6/5/1, and 18/9/6/5/1. Claims 19-21, as newly added herein, are intended to correspond to previous claims 13/9/7, 17/9/7, and 18/9/7.

Claims 13, 17, and 18 have been amended herein in a manner intended to place them in condition for allowance. Thus, in view of the above, Applicants respectfully submit that this

U.S. Patent Application Serial No. **09/939,716**
Amendment filed December 16, 2005
Reply to OA dated July 25, 2005

objection should be withdrawn. Accordingly, Applicants respectfully submit that claims 13 and 17-21 are in condition for allowance.

Claims 8, 10-12, and 16 stand rejected under the first paragraph of 35 USC 112 as failing to comply with the written description requirement. Claims 10-12 and 16 depend from claim 8. The Examiner has suggested that the subject application fails to describe in detail the following aspects of claim 8: “bandwidth of optical output of said Mach Zehnder light intensity modulator is restricted by using loss of said travelling wave type electrode.”

It is well known to restrict bandwidth using a loss of an electrode. It is well known that loss of a radio frequency transmission line, such as coplanar waveguide, a microstrip line, and a strip line, depends upon frequency. The loss in a radio frequency transmission line includes the elements such as conductor loss, dielectric loss. The higher the frequency is, the higher the loss of all the elements of a radio frequency transmission line. In a Mach Zehnder type light modulator, high frequency component of optical output is decreased when loss of high frequency component in a travelling wave type electrode increases, and the optical bandwidth is restricted by the loss.

A document with a 1991 copyright is enclosed to show information relating to restricting bandwidth using a loss of an electrode, and to: (1) support the idea that it is well known to restrict bandwidth using a loss of an electrode; and (2) demonstrate that the rejection of claim 8 under the

U.S. Patent Application Serial No. 09/939,716
Amendment filed December 16, 2005
Reply to OA dated July 25, 2005

first paragraph of 35 USC 112 should be withdrawn.

The enclosed document shows loss in a coplanar waveguide in equations 3.4.1.10 (dielectric loss), 3.4.1.11 (conductor loss), and 3.4.1.14 (radiation loss), which show that conductor loss is proportional to square root of frequency (f) (see R_s in 3.4.1.12), and dielectric loss and radiation loss are proportional to frequency (or inverse of wavelength λ_g). Thus, the desired loss characteristics are obtained by designing those losses and other parameters. As the loss increases as the frequency, the bandwidth is restricted by the loss.

In a Mach Zehnder type light modulator, high frequency component of optical output is decreased when loss of high frequency component in a travelling wave type electrode increases, and the optical bandwidth is restricted by the loss.

Thus, Applicants respectfully submit that the rejection of claim 8, 10-12, and 16 should be withdrawn.

Claims 1-5 stand rejected under 35 USC 102(b) as anticipated by USP 5,543,952 (**Yonenaga '952**) in reference to *Introduction to CMOS Design* (**Zitti**).

Claims 6, 7, 9, 14, and 15 stand rejected under 35 USC 103(a) as obvious over **Yonenaga**

U.S. Patent Application Serial No. **09/939,716**
Amendment filed December 16, 2005
Reply to OA dated July 25, 2005

in reference to **Zitti**.

Applicants respectfully traverse the above rejections of claims 1-7, 9, 14, and 15.

The Examiner suggests that **Yonenaga '952** (Fig. 1b, col. 3 at lines 33-45, col. 4 at lines 14-16, and col. 5, line 66 to col. 6, line 3) expressly or inherently describes all features set forth in claim 1, except the amplifier. The Examiner relies on **Zitti** (page 7-11) to argue that an inverter is inherently an amplifier. Thus, the Examiner is suggesting that the inverter 11 of **Yonenaga '952** (see Fig. 1b) is inherently an amplifier.

However, the Examiner has not specifically identified a publication date of **Zitti** on Form PTO-892 or in the body of the Office action. Also, the Examiner has not established that the critical reference date of **Zitti** precedes the filing of the subject application. Thus, the Examiner has not yet demonstrated that **Zitti** may be used as prior art against claims of the subject application.

In response to the above rejections of independent claims 1 and 7, please note that:

(A) the inverter 11 of **Yonenaga '952** (Fig. 1b) does not describe, teach, or suggest the amplifier as set forth in claims 1 and 7;

(B) the Examiner has not identified a publication date of **Zitti** and has not established that

U.S. Patent Application Serial No. **09/939,716**
Amendment filed December 16, 2005
Reply to OA dated July 25, 2005

Zitti can be applied as prior art against claims of the subject application, and thus the rejections of claims 1 and 7 should be withdrawn; and

(C) even if **Zitti** can be applied as prior art against claims of the subject application, **Zitti** fails to remedy the deficiencies of **Yonenaga '952**.

Thus, Applicants respectfully submit that the rejections of claims 1 and 7, and all claims depending therefrom, should be withdrawn.

The Examiner has indicated that a certified copy of the priority document may not currently be in the appropriate file of the U.S. Patent and Trademark Office. However, a certified copy of the priority document was filed on August 28, 2001. A dated postcard receipt is enclosed to demonstrate that a certified copy of the priority document was filed on August 28, 2001.

In view of the aforementioned amendments and accompanying remarks, all claims currently being examined are in condition for allowance, which action, at an early date, is requested.

If, for any reason, it is felt that this application is not now in condition for allowance, the Examiner is requested to contact the Applicants' undersigned attorney at the telephone number indicated below to arrange for an interview to expedite the disposition of this case.

U.S. Patent Application Serial No. 09/939,716
Amendment filed December 16, 2005
Reply to OA dated July 25, 2005

In the event that this paper is not timely filed, the Applicants respectfully petition for an appropriate extension of time. Please charge any fees for such an extension of time and any other fees which may be due now or in the future with respect to this application, to Deposit Account No. 01-2340.

Respectfully submitted,

ARMSTRONG, KRATZ, QUINTOS,
HANSON & BROOKS, LLP



Darren R. Crew
Attorney for Applicants
Reg. No. 37,806

DRC/llf
Atty. Docket No. 011070
Suite 1000
1725 K Street, N.W.
Washington, D.C. 20006
(202) 659-2930



23850

PATENT TRADEMARK OFFICE

Enclosures: Amendment Transmittal
Petition for Extension of Time
Document with 1991 copyright
Date-stamped Postcard Receipt

Library of Congress Cataloging-in-Publication Data

Wadell, Brian C.

Transmission line design handbook / Brian C. Wadell

p. cm.

Includes bibliographical references and index.

ISBN 0-89006-436-9

1. Strip transmission lines. 2. Microwave transmission lines.

I. Title.

TK7876.W29 1991

91-13328

621.381'31--dc20

CIP

To all my teachers—especially my father and my beautiful wife, Andrea.

British Library Cataloguing in Publication Data

Wadell, Brian C.

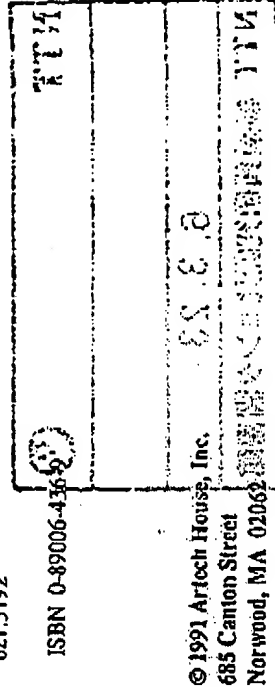
Transmission line design handbook.

1. Transmission lines

I. Title

621.3192

ISBN 0-89006-436-9



All rights reserved. Printed and bound in the United States of America. No part of this publication may be reproduced or utilized in any form or by any means, electronic or mechanical, including photocopying, recording, or by any information storage and retrieval system, without permission in writing from the publisher.

International Standard Book Number: 0-89006-436-9

Library of Congress Catalog Card Number: 91-13328

10 9 8 7 6 5

Contents

PREFACE	XV
CHAPTER 1 INTRODUCTION.....	1
1.1 Notation Used in This Book.....	1
1.2 How to Use This Book	5
CHAPTER 2 GENERALIZED TRANSMISSION LINES.....	9
2.1 Distributed Element Lines.....	9
2.2 Wave Propagation and Characteristic Impedance.....	11
2.3 Maxwell's Equations	15
2.4 Material Properties and Lumped Model.....	19
2.4.1 Complex Permeability and Permittivity.....	20
2.5 Material Classifications.....	22
2.6 Quasi-TEM Transmission Line Parameters.....	22
2.7 Transmission Line Losses.....	24
2.7.1 Conductor Losses.....	25
2.7.2 Dielectric Losses.....	27
2.7.3 Radiation Losses and Leakage Losses.....	27
2.8 Transmission Line Calculations	28
2.8.1 Line Terminated with an Arbitrary Load.....	28
2.8.2 Line Terminated with Z_0	31
2.8.3 Line Terminated with Short Circuit.....	32
2.8.4 Line Terminated with Open Circuit.....	36
2.8.5 Line Terminated with a Lumped Element.....	39
2.9 ABCD Matrix of a Generalized Transmission Line.....	41
2.10 Summary	42
CHAPTER 3 PHYSICAL TRANSMISSION LINES.....	45
3.1 Introduction	45
3.2 Coaxial Structures	47
3.2.1 Round Coaxial Cable	47
3.2.2 Partially Filled Round Coaxial Cable	53
3.2.3 Eccentric Round Coaxial Cable.....	55

3.2.5	Rectangular Coaxial Line.....	60
3.2.6	Trough Line or Channel Line.....	63
3.2.7	Strip-Centered Coaxial Line.....	64
3.3	Paired Lines.....	66
3.3.1	Parallel Wires.....	66
3.3.2	Unequal Size Parallel Wires.....	67
3.3.3	Twisted Pair.....	68
3.3.4	Five-Wire Line.....	70
3.3.5	Paired Strips.....	71
3.4	Coplanar Structures.....	73
3.4.1	Coplanar Waveguide.....	73
3.4.2	Micro-Coplanar Stripline.....	78
3.4.3	Coplanar Waveguide with Ground.....	79
3.4.4	Shielded Coplanar Waveguide.....	81
3.4.5	Asymmetric Coplanar Waveguide.....	82
3.4.6	Coplanar Strips.....	84
3.4.7	Asymmetrical Coplanar Strips.....	86
3.4.8	Three Coplanar Strips.....	87
3.4.9	Three Coplanar Strips with Ground.....	89
3.4.10	Covered Coplanar Waveguide with Ground.....	90
3.4.11	Covered Coplanar Waveguide.....	91
3.5	Microstrip Line Structures.....	93
3.5.1	Microstrip Line.....	93
3.5.2	Microstrip Line with Truncated Ground Plane and Dielectric.....	111
3.5.3	Microstrip Line with Truncated Dielectric.....	112
3.5.4	Embedded or Buried Microstrip Line.....	113
3.5.5	Nonhomogeneous Dielectric Embedded Microstrip Line.....	116
3.5.6	Shielded Microstrip Line.....	117
3.5.7	Edge-Compensated Microstrip Line (ECM Line).....	118
3.5.8	Covered Microstrip Line.....	120
3.6	Stripline Structures.....	125
3.6.1	Zero-Thickness Centered Stripline.....	125
3.6.2	Centered Stripline, Tri-Plate® or Sandwich Line.....	126
3.6.3	Off-Center Stripline.....	129
3.6.4	Shielded Stripline.....	136
3.7	Inverted Microstrip Line Structures.....	138
3.8	Suspended Microstrip Line Structures.....	141
3.8.1	Suspended Microstrip Line.....	141
3.8.2	Shielded Suspended Substrate Stripline.....	145
3.9	Other Structures.....	148
3.9.1	Cylindrical Conductor in a Corner.....	148

3.9.2	Stripline.....	149
3.9.3	Wire over Dielectric over Ground Plane.....	150
3.9.4	Bond Wire.....	151
3.9.5	Multewire®.....	154
3.9.6	Slotline.....	156
3.9.7	Finline.....	162
3.9.8	Others.....	173
3.10	Waveguides.....	174
3.10.1	Rectangular Waveguide.....	174
3.10.2	Circular Waveguide.....	177
CHAPTER 4	COUPLED LINES.....	181
4.1	Coupled Line ABCD Matrix.....	182
4.2	Coaxial Lines.....	183
4.2.1	Shielded Pair.....	183
4.2.2	Shielded Twisted Pair.....	185
4.3	Paired Lines.....	187
4.3.1	Wireline™ Coupler.....	187
4.3.2	Coupled Rectangular Coaxial Lines.....	189
4.4	Coupled Coplanar Lines.....	192
4.4.1	Broadside Coupled Coplanar Waveguide.....	192
4.4.2	Edge-Coupled CPW.....	194
4.4.3	Edge-Coupled CPWG.....	196
4.5	Coupled Microstrip Lines.....	199
4.5.1	Edge-Coupled Microstrip Lines.....	199
4.5.2	Asymmetric Coupled Microstrip Line.....	208
4.5.3	Covered Coupled Microstrip Line.....	210
4.5.4	Broadside Coupled Microstrip Lines.....	217
4.5.5	Three Coupled Microstrip Lines.....	218
4.5.6	Microstrip Line-to-Stripline Aperture Coupler.....	219
4.6	Coupled Striplines.....	222
4.6.1	Nonhomogeneous Dielectric Broadside Coupled Striplines.....	222
4.6.2	Broadside Coupled Striplines.....	226
4.6.3	Offset Coupled Striplines.....	229
4.6.4	Zero-Thickness Edge-Coupled Stripline.....	232
4.6.5	Finite-Thickness Edge-Coupled Striplines.....	234
4.6.6	Shielded Edge-Coupled Striplines.....	238
4.6.7	Asymmetric Edge-Coupled Striplines.....	240
4.7	Coupled Slablines.....	243
4.8	Coupled Suspended Substrate or Coupled Inverted Microstrip Lines.....	246
4.8.1	Edge-Coupled Suspended Substrate Lines.....	246
4.8.2	Shielded Suspended Substrate Broadside Coupled Lines.....	250

4.9.1	Coupled Slotlines.....	253
CHAPTER 5 TRANSMISSION LINE COMPONENTS AND DISCONTINUITIES..... 255		
5.1	Discontinuity Models.....	255
5.2	Coaxial Discontinuities.....	256
5.2.1	Coaxial Step in Inner Conductor.....	256
5.2.2	Coaxial Step in Outer Conductor.....	259
5.2.3	Coaxial Simultaneous Step in Inner and Outer Conductors.....	262
5.2.4	Gap in Coaxial Center Conductor.....	267
5.2.5	Coaxial Open Circuit.....	268
5.2.6	Enclosed Coaxial Open Circuit.....	270
5.3	Paired-Line Discontinuities.....	272
5.3.1	Open End.....	272
5.4	Coplanar Waveguide Discontinuities.....	274
5.4.1	Coplanar Waveguide Shunt Capacitance.....	274
5.4.2	Coplanar Waveguide Series Capacitance.....	275
5.4.3	Coplanar Waveguide Shunt Inductance.....	276
5.4.4	Coplanar Waveguide Series Inductance.....	277
5.4.5	Coplanar Waveguide Open End with Connected Grounds.....	278
5.4.6	CPW Open End.....	279
5.4.7	Coplanar Waveguide Series Gap.....	280
5.4.8	Coplanar Waveguide Abrupt Width Change.....	283
5.4.9	CPW Abrupt Ground Plane Width Change.....	284
5.4.10	Abrupt Coplanar Waveguide Bend.....	284
5.4.11	CPW Short Circuit.....	286
5.4.12	CPW Air Bridge.....	286
5.4.13	CPW Interdigital Capacitor.....	287
5.5	Microstrip Line Discontinuities.....	289
5.5.1	Microstrip Line Bend.....	289
5.5.2	Optimal Right-Angle Mitered Bend.....	291
5.5.3	Optimal Arbitrary Angle Mitered Bend.....	294
5.5.4	Microstrip Line Rounded Bend.....	297
5.5.5	Optimal Microstrip Line Rounded Bend.....	298
5.5.6	Unequal Width Bend.....	300
5.5.7	Microstrip Line Radial Stub.....	302
5.5.8	Delta Stub.....	306
5.5.9	Microstrip Line Cross.....	308
5.5.10	Microstrip Line T Junction.....	311
5.5.11	Asymmetrical Microstrip Line T Junction.....	315
5.5.12	Optimal Microstrip Line T.....	317
5.5.13	Microstrip Line Step (Abrupt Change in Width).....	319

5.5.14	Compensated Stripline Line Gap.....	324
5.5.15	Optimal Microstrip Line Linear Taper.....	326
5.5.16	Microstrip Line Double Step.....	327
5.5.17	Microstrip Line Open.....	328
5.5.18	Coupled Microstrip Line Open End.....	330
5.5.19	Microstrip Line Gap.....	332
5.5.20	Asymmetric Microstrip Line Gap.....	336
5.5.21	Microstrip Line Finger Break.....	338
5.5.22	Microstrip Line Zig-Zag Slit.....	338
5.5.23	Arbitrary Angle Microstrip Line Bend.....	339
5.5.24	Microstrip Line Y Junction.....	340
5.5.25	Slit in Microstrip Line.....	342
5.5.26	Microstrip Line Spur Line.....	343
5.5.27	Air Bridges.....	344
5.5.28	Coupled Microstrip Line Right-Angle Bends.....	345
5.6	Stripline Discontinuities.....	347
5.6.1	Abrupt Stripline 90° Bend.....	347
5.6.2	Arbitrary Angle Stripline Bend.....	348
5.6.3	Optimal Stripline Mitered 90° Bend.....	350
5.6.4	Optimal Stripline Rounded Bend.....	351
5.6.5	Stripline Abrupt Width Change.....	352
5.6.6	Compensated Stripline Step Discontinuities.....	354
5.6.7	Stripline Open End.....	356
5.6.8	Stripline T Junction.....	358
5.6.9	Stripline Gap in Center Conductor.....	360
5.6.10	Stripline Round Hole in Center Conductor.....	361
5.6.11	Stripline Slot in Center Conductor.....	362
5.6.12	Stripline Multistrip Junction.....	364
5.6.13	Stripline Slot in Ground Plane.....	366
5.7	Suspended Microstrip Line.....	368
5.7.1	Abrupt Width Change and Open End.....	368
5.7.2	Asymmetric Gap.....	368
5.8	Finline Discontinuities.....	370
5.9	Other Discontinuities.....	372
5.9.1	Plated-Through Hole or Via.....	372
5.9.2	Optimal Plated-Through Hole or Via.....	379
5.9.3	Wraparound Ground.....	380
CHAPTER 6 INDUCTORS..... 381		
6.1	ABCD Matrices.....	381
6.2	Wire Inductors.....	382
6.2.1	Round Wire Inductor.....	382
6.2.2	Flat Wire Inductor.....	384
6.2.3	Cylinder or Round Tubular Inductor.....	386

6.3.1	Round or Square Helical Coil Inductor.....	388
6.4	Planar or Pancake Inductors.....	391
6.4.1	Planar Circular Spiral Inductors.....	391
6.4.2	Planar Square Spiral Inductor.....	398
6.4.3	Single-Turn Circular Planar Inductor.....	403
6.4.4	Single-Turn Rectangular Planar Inductor.....	404
6.4.5	Octagonal Spiral Inductor.....	405
6.5	Toroidal Inductors.....	407
6.5.1	Toroidal Inductor on Form with Square Cross-Section.....	408
6.5.2	Toroidal Inductor on Form with Circular Cross-Section.....	409
6.6	Mutual Inductances.....	409
6.6.1	Parallel Wires.....	410
6.6.2	Parallel Rectangular Wires.....	412
CHAPTER 7	CAPACITORS.....	415
7.1	ABCD Matrices.....	415
7.2	Parallel-Plate Capacitor.....	416
7.3	Multilayer Dielectric Parallel-Plate Capacitor.....	417
7.4	Thin-Film Capacitors.....	418
7.5	Multilayer Capacitor.....	419
7.6	Interdigital Capacitor.....	420
7.7	Concentric Cylinders.....	423
7.8	Capacitor Dielectric Constants and Loss Tangents.....	423
CHAPTER 8	RESISTORS.....	425
8.1	ABCD Matrices.....	425
8.2	Rectangular Planar Resistor.....	425
8.3	Leaded Resistors.....	427
8.4	Coaxial Resistors.....	428
8.5	Meander Line Resistors.....	429
CHAPTER 9	PRINTED CIRCUIT FABRICATION.....	431
9.1	PCB Construction.....	431
9.1.1	Designing a Layout.....	433
9.2	Substrate Dielectrics.....	434
9.2.1	Properties of Commercial Dielectrics.....	434
9.2.2	Effect of Resin/Glass Mix on ϵ_r of FR-4.....	438
9.2.3	Ceramic Dielectrics.....	440
9.2.4	Flexible PCB Dielectrics.....	440
9.2.5	Semiconductor Dielectrics.....	441
9.2.6	Properties of Other Dielectric Materials.....	441
9.2.7	Dielectric Dimensions and Tolerances.....	442

9.3.1	Standard Conductive Layers and Tolerances.....	444
9.3.2	Metal Thickness.....	444
9.3.3	Trace Width Tolerances.....	444
9.3.4	Minimum Trace Widths and Line Spacings.....	445
9.3.5	Plating.....	445
9.3.6	Electrical Properties of Metals.....	446
9.3.7	Metal Roughness.....	447
9.4	Plated-Through Holes or Vias.....	448
9.5	Solder Mask.....	450
CHAPTER 10	CABLE DIELECTRICS.....	453
CHAPTER 11	WIRE GAUGES.....	455
11.1	Fusing Current.....	455
11.2	Wire Gauge.....	456
11.3	Bond Wires.....	458
CHAPTER 12	SPECIAL FUNCTIONS.....	459
12.1	Standard Functions.....	459
12.2	Special Functions.....	460
12.2.1	Hyperbolic Functions.....	460
12.2.2	Elliptic Integrals.....	460
12.2.3	Bessel Functions.....	464
12.2.4	Sine-Integral Function.....	471
12.2.5	Gamma Function.....	472
12.2.6	Hencken Impedance Function.....	472
12.3	Two-Port Representations.....	474
12.3.1	Scattering or s -Parameters.....	474
12.3.2	Transmission or T -Parameters.....	475
12.3.3	ABCD Matrices.....	476
12.3.4	Series Combinations of Two-Port Networks.....	478
12.3.5	Parallel Combinations of Two-Port Networks.....	478
GLOSSARY	483
APPENDIX A	LIST OF SYMBOLS, ACRONYMS, AND ABBREVIATIONS.....	487
APPENDIX B	COMMON QUESTIONS AND ANSWERS.....	491
APPENDIX C	VSWR, REFLECTION COEFFICIENT, AND IMPEDANCE.....	497
INDEX	501

- [16] Metzger, Georges, et al., *Transmission Lines with Pulse Excitation*, Academic Press, New York, 1969. (Transmission line propagation from the digital engineer's perspective.)
- [17] Ramo, Simon, John R. Whinnery, and Theodore Van Duzer, *Fields and Waves in Communication Electronics*, John Wiley & Sons, New York, 1984. (A classic text that has been revised several times since the first version, *Fields and Waves in Modern Radio* in 1944. Good example problems.)
- [18] Sander, K.F., and G.A.L. Reed, *Transmission and Propagation of Electromagnetic Waves*, Cambridge University Press, Cambridge, 1986.
- [19] Steele, Charles W., *Numerical Computation of Electric and Magnetic Fields*, Van Nostrand Reinhold Company, New York, 1987.
- [20] Waldow, Peter, and Ingo Wolff, "The Skin-Effect at High Frequencies," *IEEE Transactions on Microwave Theory and Techniques*, Vol. MTT-33, No. 10, October 1985, pp. 1076-1082.
- [21] Young, Leo, ed., *Advances in Microwaves*, Volume 1, "Directional Couplers," by R. Levy, Academic Press, New York, 1966, pp. 115-209. (An excellent discussion.)
- [22] Young, Leo, ed., *Parallel Coupled Lines and Directional Couplers*, Artech House, Norwood, MA, 1972. (A very good collection of papers relating to the understanding and design of coupled lines of various types.)

Chapter 3

Physical Transmission Lines

3.1 INTRODUCTION

In this chapter we transform our knowledge about the generalized transmission line calculations into actual physical realizations for a wide variety of configurations. Structures are grouped into major categories: coaxial, paired lines, coplanar, microstrip line, stripline, waveguide, and others. Within each category, a number of nonstandard configurations are included to illustrate the effects of variations from the standard structure. Tables and graphs are generally excluded because it is assumed that the reader has access to and will use the *Transmission Line Design Software* available as part of this text.

ABCD matrices for the lines in this chapter are found in Chapter 2. The equations of this chapter allow calculation of Z_0 in the matrices from the line's physical dimensions. The electrical length is calculated from the operating frequency, f , and the physical length, l , using ϵ_{eff} .

$$\theta = 2.0 \pi l f \frac{\sqrt{\epsilon_{eff}}}{c} \quad (\text{radians}) = 360.0 l f \frac{\sqrt{\epsilon_{eff}}}{c} \quad (\text{degrees}) \quad (3.1.1)$$

A number of the older and commonly referenced articles are available as part of reprint collections listed below. Two of these, [2] and [4] are out of print but they may be found in libraries. Consulting these can save considerable time.

REFERENCES

- [1] Itoh, T., ed., *Planar Transmission Line Structures*, IEEE Press, NY, 1987.
- [2] Frey, J., ed., *Microwave Integrated Circuits*, Artech, Norwood, MA, 1975.
- [3] Frey, J., and Kul Bhassin, eds., *Microwave Integrated Circuits*, 2nd Ed., Artech House, Norwood, MA, 1985. (The second edition of [2] with a new group of papers.)

- [4] Young, L., ed., *Parallel Coupled Lines and Directional Couplers*, Artech, Norwood, MA, 1972.

3.2 COAXIAL STRUCTURES

3.2.1 Round Coaxial Cable

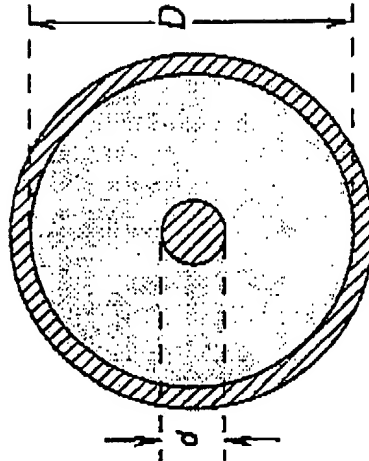


Figure 3.2.1.1: Round Coaxial Cable

The equations for this transmission line can be derived easily and are exact for the case of an infinitely long line (no fringing fields):

$$Z_0 = \frac{\eta_0}{2.0 \pi \sqrt{\epsilon_r}} \ln \left(\frac{D}{d} \right) \quad (\Omega) \quad (3.2.1.1)$$

$$\alpha_c = \left(\frac{0.014272 \sqrt{f}}{Z_0} \right) \left(\frac{1}{d} + \frac{1}{D} \right) \quad (\text{dB/m}) \quad (3.2.1.2)$$

$$\alpha_d = 0.091207 f \sqrt{\epsilon_r} \tan \delta \quad (\text{dB/m}) \quad (3.2.1.3)$$

For inner and outer conductors having equal conductivity, the optimal D/d for breakdown voltage is 2.718; for optimal power transfer, 1.65; and for minimum attenuation, 3.59 [7, 13]. See [7] for information on optimizing these parameters.

Coaxial connectors have mechanical tolerances of ± 0.0025 mm and ± 0.005 mm for laboratory and general precision, respectively. For a 50 Ω connector, this corresponds to about 0.5% and 0.8% tolerance on the impedance.

To reduce losses, we might increase d and D , keeping their ratio constant to lower α_c . However, the coaxial wire of Figure 3.2.1.1 will propagate higher order modes.

The cutoff frequency of these modes decreases with increasing d , and D placing a limitation on the cable size for a desired useful frequency range. Marcuvitz [11] gives the relations for the higher order modes, which begin at approximately 1.5 times the TE₁₁ mode. The first higher order mode begins to propagate when

$$\lambda_{C11} = \frac{2.0 \pi}{\beta_{x1}} \quad (3.2.1.4)$$

where β_{xm} is the first ($m = 1$) solution of

$$\frac{J_1'(\beta_{xm} R)}{N_1'(\beta_{xm} R)} = \frac{J_1'(\beta_{xm} r)}{N_1'(\beta_{xm} r)} \quad (3.2.1.5)$$

where

$$r = d/2.0 \quad (3.2.1.6)$$

$$R = D/2.0 \quad (3.2.1.7)$$

Dimitrios [5] rewrites the above by replacing derivative forms of Bessel functions with nonderivative forms. This form is more accurate when used with available tables of Bessel functions:

$$\frac{J_0'(\beta_{xm} R) - \frac{1}{\beta_{xm} R} J_1'(\beta_{xm} R)}{N_0'(\beta_{xm} R) - \frac{1}{\beta_{xm} R} N_1'(\beta_{xm} R)} = \frac{J_0'(\beta_{xm} r) - \frac{1}{\beta_{xm} r} J_1'(\beta_{xm} r)}{N_0'(\beta_{xm} r) - \frac{1}{\beta_{xm} r} N_1'(\beta_{xm} r)} \quad (3.2.1.8)$$

Green [8] derives an expression for the wavelength at which this occurs (TE₁₁ mode begins to propagate):

$$\lambda_c = 2 \pi r_m \left[1.0 - \frac{1.0}{6.0} \left(\frac{r}{2.0 r_m} \right)^2 - \frac{7.0}{120.0} \left(\frac{r}{2.0 r_m} \right)^4 - \dots \right] \quad (3.2.1.9)$$

where

$$r_m = \frac{d + D}{2.0} \quad (3.2.1.10)$$

$$t = D - d \quad (3.2.1.11)$$

The stated agreement with Marcuvitz's Bessel function solution is better than 1% for $D/d < 2.5$, and better than 4% for $D/d < 4.0$. The number of terms used to reach this agreement is not stated.

A simple approximation to the above is:

$$\lambda_c \approx \frac{\pi (D + d)}{2.0} \quad (\text{units of } D, d) \quad (3.2.1.12)$$

which is the circumference of a circle with radius midway between the inner and outer conductors. Dimitrios [5] compared the accuracy of the equation above to the exact solution and found that it is generally accurate to 3% for 50 Ω lines with various dielectrics.

A lesser known fact about real-world coaxial cables is that they can introduce nonlinear distortion at a low level. Amin [3] presents data at the L, S, and C (390 MHz to 10.9 GHz) bands for various commercial cables showing that braided cables can have distortion products down 90 to 115 dB from the carrier depending on construction. Solid shields had no distortion. Nickel-plated, stainless steel, and Al alloy braids had distortion down 90 to 95 dB from the carrier. Distortion increased with power, frequency, and cable length.

3.2.1.1 Example: Coaxial Pogo Pin

We wish to design a 50 Ω controlled impedance path that launches from a microstrip line and makes use of a standard size (0.040" o.d.) pogo pin (a spring-loaded pin used in ATE equipment) as the center conductor. This configuration is of use in test equipment where a controlled Z path must be blind-mated repeatedly, as in Figure 3.2.1.2. Calculate the required shield dimensions for both air and PTFE dielectrics.

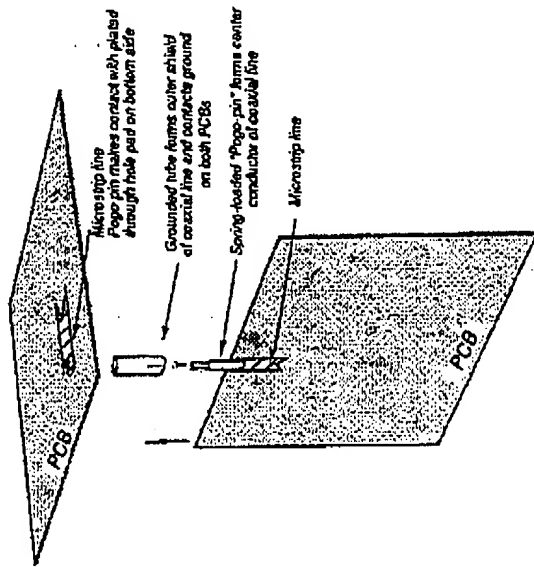


Figure 3.2.1.2: Coaxial Pogo-Pin Example

Solution:

$$Z_0 = 50 \Omega = \frac{\eta_0}{2.0 \pi \sqrt{\epsilon_r}} \ln \left(\frac{D}{d} \right) \Omega$$

For air

$$50 \Omega = \frac{377}{2 \pi \sqrt{1}} \ln \left(\frac{D}{0.040} \right) \Omega$$

$$\boxed{D = 0.092''}$$

For PTFE:

$$50 \Omega = \frac{377}{2 \pi \sqrt{2.1}} \ln \left(\frac{D}{0.040} \right) \Omega$$

$$\boxed{D = 0.134''}$$

A number of companies have attempted to combine the 360° shielding benefits of the coaxial structure with the fabrication advantages of printed-circuit boards (PCBs). This is increasingly an issue as the density and speeds of digital circuitry increase. See also [15] for a planar structure constructed with additive techniques. See Section 3.2.5 for more information.

Swengel *et al.* [18] describe a technique for machine wiring coaxial lines on PCB. The technique point-to-point wires 3.14 mil wires coated with a 10 mil thick layer of PTFE. The wire ends are then plated together. The PTFE is plated, creating the coaxial shield. A final selective etch separates the wire ends as required. Because of the solid ground plane, wave-soldering is difficult. The technique is also sensitive to handling and vibration.

A similar technique, described in [21], uses a semirigid cable (PTFE, $D = 9.5$ mil, $d = 3.14$ mil), which is also machine routed point-to-point. The wires are laid down on an adhesive layer during routing and then the shields are plated together. The wire is stripped at its ends, coated with epoxy and the center conductors are plated to plated-through holes. This structure is easily used as part of a multilayer PCB.

REFERENCES

- [1] Adair, Robert T., and Eleanor M. Livingston, "Coaxial Intrinsic Impedance Standards," *U.S. Department of Commerce, NIST Technical Note 1333*, October 1989.
- [2] Alford, Andrew, "Higher Modes in Insulating Beads," *Microwave Journal*, March 1990, pp. 146–156.
- [3] Amin, M.B., and I.A. Benson, "Nonlinear Effects in Coaxial Cables at Microwave Frequencies," *Electronics Letters*, December 8, 1977, Vol. 13, No. 25, pp. 768–770.
- [4] Daywitz, William C., "First-Order Symmetric Modes for a Slightly Loss Coaxial Transmission Line," *IEEE Transactions on Microwave Theory and Techniques*, Vol. 38, No. 11, November 1990, pp. 1644–1650. (Maxwell's equations are solved for a slightly lossy line resulting in new, more accurate results. A significant correction is made to calculations of the distributed resistance.)
- [5] Dimitrios, James, "Exact Cutoff Frequencies of Precision Coax," *Microwaves*, June 1965, pp. 28–31.
- [6] Franke, Ernie, "Minimum Attenuation Geometry for Coaxial Transmission Line," *RF Design*, May 1989, pp. 58–62.
- [7] Green, E.I., *et al.*, "The Proportioning of Shielded Circuits for Minimum High-Frequency Attenuation," *The Bell System Technical Journal*, 1936, pp. 248–283.
- [8] Green, Harry E., "Determination of the Cutoff of the First Higher Order Mode in a Coaxial Line by the Transverse Resonance Technique," *IEEE Transactions on Microwave Theory and Techniques*, Vol. 37, No. 10, October 1989, pp. 1652–

- [9] Hubbard, George, "Technique Links SMA Connectors to Flexible Coax Cables," *Microwaves & RF*, June 1990, pp. 156-158, 163.
- [10] MacKenzie, T.E. and A.E. Sanderson, "Some Fundamental Design Principles for the Development of Precision Coaxial Standards and Components," *IEEE Transactions on Microwave Theory and Techniques*, MTT-14, No. 1, January 1966, pp. 29-39.
- [11] Marcuvitz, N., *Waveguide Handbook*, McGraw-Hill, 1955. Reprint with errata and preface by N. Marcuvitz. Peter Peregrinus Ltd., 1986.
- [12] Maury, Mario A., Jr., "Microwave Coaxial Connector Technology: A Continuing Evolution," *Microwave Journal*, 1990 State of the Art Reference, pp. 39-59. (A good overview and history of coaxial connectors.)
- [13] Moreno, T., ed., *Microwave Transmission Design Data*, Sperry Gyroscope Company, Great Neck, New York, Publication No. 23-80, 1944. (Reprint available from Artech House, Norwood, MA, 1989.)
- [14] Neubauer, H., and F.R. Huber, "Higher Modes in Coaxial RF Lines," *The Microwave Journal*, June 1969, pp. 57-66.
- [15] Salvage, Seward T., et al., "Design and Construction of a Thick-Film Shielded Strip Transmission Line," *1981 IEEE Southeastcon Conference Proceedings*, pp. 7-11.
- [16] Schelkunoff, S.A., "The Electromagnetic Theory of Coaxial Transmission Lines and Cylindrical Shields," *The Bell System Technical Journal*, October 1934, Vol. XII, No. 4, October 1934, pp. 532-579. (Probably the best single reference for the coaxial line.)
- [17] Spaderna, Conan H., "A New Formula for Attenuation in Coaxial Cables," *IEEE Transactions on Microwave Theory and Techniques*, Vol. MTT-12, No. 5, May 1964, pp. 363-364.
- [18] Swengel, Sr., Robert C., et al., "A Coaxial Interconnection System for High Speed Digital Processors," *IEEE Transactions on Parts, Hybrids, and Packaging*, Vol. PHP-10, No. 3, September 1974, pp. 181-187.
- [19] Weinschel, Bruno O., "Errors in Coaxial Air Line Standards Due to Skin Effect," *Microwave Journal*, November 1990, pp. 131-143.
- [20] Wheeler, Harold A., "Transmission-Line Properties of a Round Wire in a Polygon Shield," *IEEE Transactions on Microwave Theory and Techniques*, Vol. MTT-27, No. 8, August 1979, pp. 717-721.
- [21] Wong, Kenneth H., "Using Precision Coaxial Air Dielectric Transmission Lines as Calibration and Verification Standards," *Microwave Journal*, December 1988, pp. 83-92. (Discusses mechanical precision requirements for coaxial standards.)

[22] "Embedded Coaxial Wires Speed Printed-Circuit Board," *Electronics*, January 27, 1986, pp. 56-57.

[23] Young, Leo, ed., *Advances in Microwaves*, Volume 6, "Precision Coaxial Connectors," by Robert C. Powell, Academic Press, New York, 1971.

3.2.2 Partially Filled Round Coaxial Cable

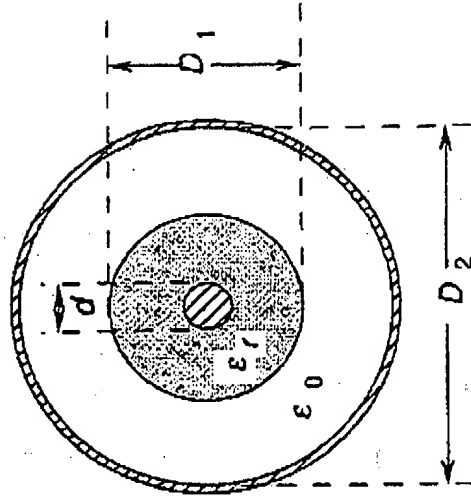


Figure 3.2.2.1: Partially Filled Round Coax

This case is encountered where a low-loss line is being constructed and the dielectric losses need to be reduced by making part of the dielectric air. It also occurs when the dielectric diameter is reduced over a portion of its length for assembly.

$$Z_0 = \frac{\eta_0}{2\pi} \ln\left(\frac{D_2}{d}\right) \sqrt{\frac{\epsilon_r \ln\left(\frac{D_2}{d}\right) + \ln\left(\frac{D_2}{d}\right)}{\epsilon_r \ln\left(\frac{D_2}{d}\right)}} \quad (3.2.2)$$

Ragan [3] also discusses the matching of such structures by proper choice of dimensions. Hatsuda [1] analyzes a round coaxial structure with wedges of dielectric removed.

3.2.2.1 Example: Calculating q for a Partially Filled Coaxial Line

... ..

Solution: The ratio of the structure's actual capacitance to its capacitance with solid air as the dielectric is defined as q . We can easily get C_{air} from the solid dielectric structure:

$$C_{air} = \frac{2 \pi \epsilon_0}{\ln \left(\frac{D_2}{d} \right)}$$

and using the relationships in Chapter 1 we can write the capacitance in terms of the known Z_0 :

$$C_{actual} = \frac{\sqrt{\mu_0 \epsilon}}{Z_0}$$

$$q = \frac{C_{actual}}{C_{air}} = \frac{\frac{\sqrt{\mu_0 \epsilon}}{Z_0}}{\frac{2 \pi \epsilon_0}{\ln \left(\frac{D_2}{d} \right)}} = \frac{\frac{\sqrt{\mu_0 \epsilon}}{Z_0} \ln \left(\frac{D_2}{d} \right)}{2 \pi \epsilon_0}$$

$$q = \frac{\epsilon_r}{\sqrt{\frac{\epsilon_r \ln \left(\frac{D_2}{d} \right) + \ln \left(\frac{D_1}{d} \right)}{\epsilon_r \ln \left(\frac{D_2}{d} \right)}}}$$

REFERENCES

- [1] Halsuda, Takeshi, "Computation of Impedance of Partially Filled and Slotted Coaxial Line," *IEEE Transactions on Microwave Theory and Techniques*, MTT-15, No. 11, November 1967, pp. 643-644.
- [2] Kraus, J.D., *Electromagnetics*, McGraw-Hill, New York, 1953.
- [3] Ragan, George L., ed., *Microwave Transmission Circuits*, MIT Radiation Laboratory Series: Volume 9, McGraw-Hill, New York, 1948.

- [4] Sullivan, D.J., and D.A. Parkes, "Stepped Transformers for Partially Filled Transmission Lines," *IEEE Transactions on Microwave Theory and Techniques*, MTT-8, No. 2, March 1960, pp. 212-217.

3.2.3 Eccentric Round Coaxial Cable

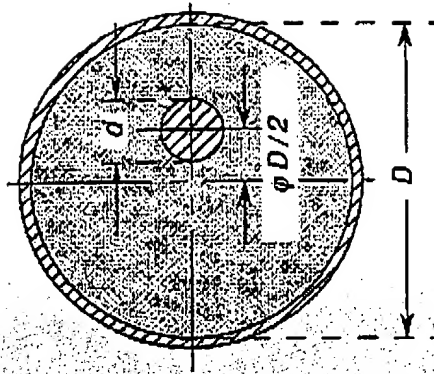


Figure 3.2.3.1: Eccentric Round Coaxial Cable

The eccentric coax equations enable us to analyze the effects of tolerances in the manufacture of the cable. This structure has also been used as a continuously adjustable $\lambda/4$ line. The center conductor is moved within the outer shield by a mechanical probe resulting in smooth variation of the characteristic impedance.

For center conductors off center in one direction, [1] gives:

$$Z_0 = \frac{\eta_0}{2.0 \pi \sqrt{\epsilon_r}} \cosh^{-1} \left[\frac{D}{2.0 d} (1.0 - \phi^2) + \frac{d}{2.0 D} \right] (\Omega) \quad (3.2.3.1)$$

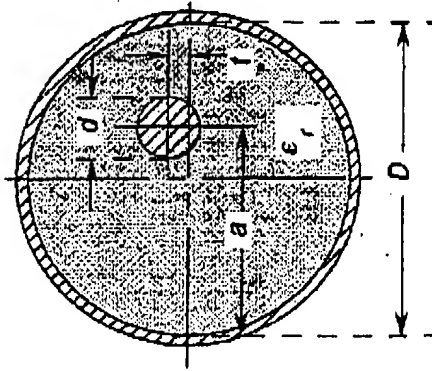


Figure 3.2.3.2: Eccentric Round Coaxial Cable

For center conductors that are eccentric in both directions, as in Figure 3.2.3.2 [2]:

$$Z_0 = \left[\frac{\eta_0}{2\pi\sqrt{\epsilon_r}} \ln \left(\frac{D}{d} \right) \right] \left[1.0 - \frac{e^2 k^2}{(k^2 - 1.0) \log k} \right] (\Omega) \quad (3.2.3.2)$$

where

$$b = \frac{d}{2.0} \quad (3.2.3.3)$$

$$c = r \quad (3.2.3.4)$$

$$e = \frac{c}{a} \quad (3.2.3.5)$$

$$k = \frac{a}{b} \quad (3.2.3.6)$$

The conductor losses of this line are

$$\alpha_c = \alpha_{c,centered} \left[1.0 + \frac{2.0 e^2}{k} - \frac{e^2 k^2}{(k^2 - 1.0) \log k} \right] (\text{dB/m}) \quad (3.2.3.7)$$

$\alpha_{c,centered}$ = conductor losses of the centered line calculated with (3.2.1.2).

REFERENCES

- [1] Moreno, T., ed., *Microwave Transmission Design Data*, Sperry Gyroscope Company, Great Neck, New York, Publication No. 23-80, 1944. (Reprint by Artech House, Norwood, MA, 1989.)
- [2] Schelkunoff, S.A., "The Electromagnetic Theory of Coaxial Transmission Lines and Cylindrical Shields," *The Bell System Technical Journal*, October 1934, Vol. XIII, No. 4, pp. 532-579. (Probably the best single reference for the coaxial line.)

3.2.4 Square Coaxial Cable

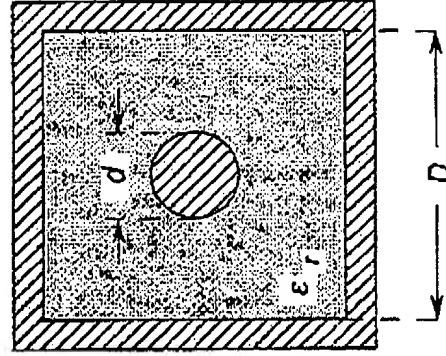


Figure 3.2.4.1: Square Coaxial With Circular Center Conductor

The square coaxial wire configurations are useful at very high frequencies as smaller replacements for waveguide. The square cross section makes them easier to fabricate than a round coax.

For the round center conductor as shown in Figure 3.2.4.1:

$$Z_0 = \frac{\eta_0}{2\pi\sqrt{\epsilon_r}} \ln \left[\frac{1.0787 D}{d} \right] (\Omega) \quad (3.2.4.1)$$

and for $Z_0 \leq 2.0 \Omega$

$$Z_0 = 21.2 \sqrt{D/d - 1.0} (\Omega) \quad (3.2.4.2)$$

which was derived by S. Frankel. Error of the first equation is less than 1.5% above 17 Ω and very small above 30 Ω [2]. The second equation is accurate to 0.5 Ω .

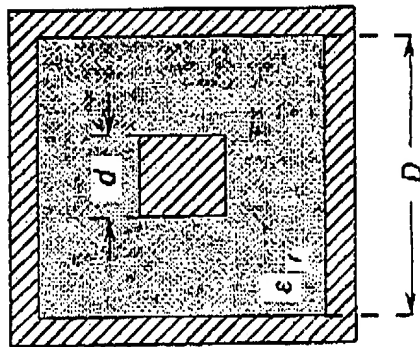


Figure 3.2.4.2: Square Coax with Square Center Conductor

For the square center conductor configuration shown in Figure 3.2.4.2 a conformal mapping solution is available [6]:

$$Z_0 = 5.0 \pi v_p \times 10^{-8} \frac{K(k')}{K(k)} = \frac{5.0 \pi c}{\sqrt{\epsilon_r}} \frac{K(k')}{K(k)} \times 10^{-8} \quad (\Omega) \quad (3.2.4.3)$$

$$k = \frac{(\Lambda' - \Lambda)^2}{(\Lambda' + \Lambda)^2} \quad (3.2.4.4)$$

$$\Lambda' = \sqrt{1.0 - \Lambda^2} \quad (3.2.4.5)$$

where Λ is the solution to:

$$\frac{K(\Lambda')}{K(\Lambda)} = \frac{D-d}{D+d} \quad (3.2.4.6)$$

This can be solved iteratively with an equation solver or using the relations of Chapter 12. Observe that the above is always ≥ 0 and ≤ 1 .

An approximation [6] is:

$$Z_0 \approx \frac{1.0}{4.0 v_p (C_{pp} + C_c)} = \frac{70}{\sqrt{\epsilon_r}} \left[\frac{1.0}{4.0 \left(\frac{2.0 d}{D-d} + 0.558 \right)} \right] (\Omega) \quad (3.2.4.7)$$

which can be seen to be the equation for four parallel plate capacitors (C_{pp}) added to the four corner capacitances (C_c). The accuracy of the above equation is better than 1% for

$$D/d \leq 4.0$$

REFERENCES

- [1] Alessandri, F., and R. Sorrentio, "Analysis of T-Junction in Square Coaxial Cable," *18th European Microwave Conference Proceedings*, 1988, pp. 162-167.
- [2] Cohn, Seymour B., "Beating a Problem to Death," *Microwave Journal*, Vol. 12, No. 11, November 1969, pp. 22-24.
- [2a] Green, H.E., and J.D. Cashman, "Higher Order Mode Cutoff in Polygonal Transmission Lines," *IEEE Transactions on Microwave Theory and Techniques*, Vol. MTT-33, No. 1, January 1985, pp. 67-69.
- [3] Hillberg, Wolfgang, "From Approximations to Exact Relations for Characteristic Impedances," *IEEE Transactions on Microwave Theory and Techniques*, Vol. MTT-17, No. 5, May 1969, pp. 259-265.
- [4] Liao, Samuel Y., *Microwave Circuit Analysis and Amplifier Design*, Prentice-Hall, Englewood Cliffs, NJ, 1987.
- [5] Wheeler, Harold A., "Transmission-Line Properties of a Round Wire in a Polygon Shield," *IEEE Transactions on Microwave Theory and Techniques*, Vol. MTT-27, No. 8, August 1979, pp. 717-721.
- [6] Young, Leo, ed., *Advances in Microwaves*, Volume 2, "The Numerical Solution of Transmission Line Problems," by Harry E. Green, Academic Press, New York, 1967.

3.2.5 Rectangular Coaxial Line

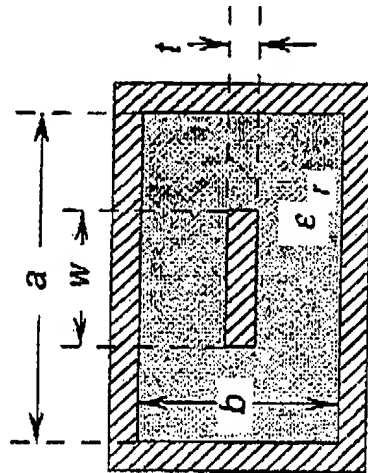


Figure 3.2.5.1: Rectangular Coaxial Line

This structure is a transitional structure between round coax and stripline, microstrip line or other planar lines. Many attempts have been made to utilize this structure for photolithographic construction of fully shielded controlled impedance lines. Rotating the center conductor relative to the shield also allows this structure to have a continuously variable characteristic impedance [4].

As reported in [9] rectangular coax can be used in PCBs constructed with additive techniques to obtain a completely shielded structure. The process by Augat Microtec builds the structure using photolithographic techniques from polyimide and copper.

A related structure [14], Figure 3.2.5.2, was constructed with thick-film techniques. The main limitation appears to have been the thickness, b , achievable without excessive layered printings. Without a sufficiently thick dielectric, center conductor to shield shorts were common. Low dielectric constant pastes were recommended.

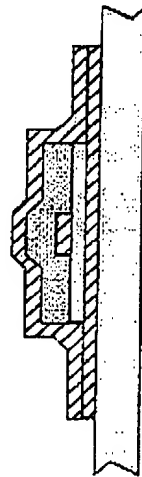


Figure 3.2.5.2: Thick-Film Coaxial Line

$$Z_0 = \frac{\eta_0}{4.0 \sqrt{\epsilon_r}} \left[\frac{1.0}{1.0 - t/b} + \frac{2.0}{\pi} \ln \left(\frac{1.0}{1.0 - t/b} + \coth \frac{\pi a}{2.0 b} \right) \right] (\Omega) \quad (3.2.5.1)$$

for a square shield and center conductor, $a = b$ and $w = t$:

$$Z_0 = \frac{\eta_0}{4.0 \sqrt{\epsilon_r}} \left[\frac{1.0}{b/t - 1.0} + \frac{2.0}{\pi} \ln \left(\frac{1.0}{1.0 - t/b} + \coth \frac{\pi}{2.0} \right) \right] (\Omega) \quad (3.2.5.2)$$

As stated earlier, rectangular coaxial structures are also useful at extremely high frequencies as a smaller replacement for waveguide that is more easily fabricated than round coax.

Rotation of the center conductor varies the characteristic impedance of the line. The equations are in Cruz and Brooke, [4]:

$$Z(\theta) = \frac{Z(0^\circ) (1.0 + \cos 2.0\theta) + Z(90^\circ) (1.0 - \cos 2.0\theta)}{2.0} (\Omega) \quad (3.2.5.3)$$

where $Z(0^\circ)$ and $Z(90^\circ)$ are calculated with any of the equations for a rectangular line above. Although the calculations of $Z(0^\circ)$ and $Z(90^\circ)$ were out of range for the [2] and [1] equations, agreement with experimental data to better than 1.4% was achieved.

REFERENCES

- [1] Chen, Tsung-Shan, "Determination of the Capacitance, Inductance, and Characteristic Impedance of Rectangular Lines," *IRE Transactions on Microwave Theory and Techniques*, Vol. MTT-8, No. 9, September 1960, pp. 510-519.
- [2] Cohn, Seymour B., "Characteristic Impedance of the Shielded-Strip Transmission Line," *Transactions of the IRE*, Vol. MTT-2, July 1954, pp. 52-57.
- [3] Conning, S.W., "The Characteristic Impedance of Square Coaxial Line," *IEEE Transactions on Microwave Theory and Techniques*, Vol. 12, No. 4, April 1964, pp. 468-469.
- [4] Cruz, J.E., and R.L. Brooke, "A Variable Characteristic Impedance Coaxial Line," *IEEE Transactions on Microwave Theory and Techniques*, MTT-13, No. 4, April 1965, pp. 477-478.
- [5] Cruzan, O.R., and R.V. Garver, "Characteristic Impedance of Rectangular Coaxial Transmission Lines," *IEEE Transactions on Microwave Theory and Techniques*,

- "Characteristic Impedance of Rectangular Coaxial Transmission Lines," Vol. MTT-32, No. 2, February 1984, p. 219.
- [6] Garver, Robert V., "Z₀ of Rectangular Coax," *IEEE Transactions on Microwave Theory and Techniques*, Vol. MTT-9, No. 3, May 1961, pp. 262-263.
- [7] Green, Harry E., "The Characteristic Impedance of Square Coaxial Line," *IEEE Transactions on Microwave Theory and Techniques*, Vol. 11, No. 11, November 1963, pp. 554-555.
- [8] Grunet, L., "Higher Order Modes in Rectangular Coaxial Waveguides," *IEEE Transactions on Microwave Theory and Techniques*, Vol. MTT-15, No. 8, August 1967, pp. 483-485.
- [9] Landis, Richard C., "Buried Coaxial Conductors for High-Speed Interconnections," *IEEE Transactions on Components, Hybrids, and Manufacturing Technology*, Vol. CHMT-10, No. 2, June 1987, pp. 204-208.
- [10] Lau, K.H., "Loss Calculations for Rectangular Coaxial Lines," *IEEE Proceedings*, Vol. 135, Pt. H, No. 3, June 1988, pp. 207-209.
- [11] Riblet, Henry J., "An Expansion for the Fringing Capacitance," *IEEE Transactions on Microwave Theory and Techniques*, Vol. MTT-28, No. 3, March 1980, pp. 265-267.
- [12] Riblet, Henry J., "Upper Limits on the Error of an Improved Approximation for the Characteristic Impedance of Rectangular Coaxial Line," *IEEE Transactions on Microwave Theory and Techniques*, Vol. MTT-28, No. 6, June 1980, pp. 666-667.
- [13] Salvage, Seward T., et al., "Design and Construction of a Thick-Film Shielded Strip Transmission Line," 1981 *IEEE Southeastcon Conference Proceedings*, pp. 7-11.
- [14] Terakato, Ryuiti, "The Characteristic Impedance of Rectangular Coaxial Line with Ratio 2:1 of Outer-to-Inner Conductor Side Length," *IEEE Transactions on Microwave Theory and Techniques*, Vol. 24, No. 2, February 1976, pp. 124-125.
- [15] Tippet, John C., and David C. Chang, "A New Approximation for the Capacitance of a Rectangular Coaxial-Strip Transmission Line," *IEEE Transactions on Microwave Theory and Techniques*, Vol. MTT-24, No. 9, September 1976, pp. 602-604.

3.2.6 Trough Line or Channel Line

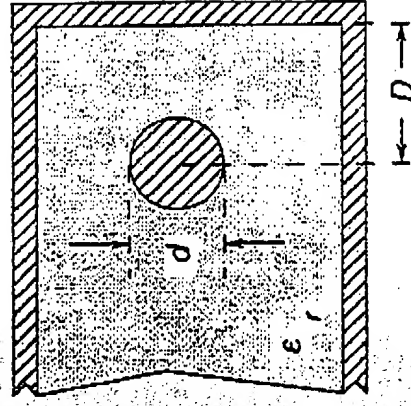


Figure 3.2.6: Trough Line

Wheeler [2] gives:

$$Z_0 = \frac{170}{4\pi\sqrt{\epsilon_r}} \ln \left[1.0 + \left\{ \frac{1}{2} \left(\frac{4}{\pi} \tanh \frac{\pi}{2} \right)^2 \left[(D/d)^2 - 1.0 \right] \right\} \right]$$

$$+ \sqrt{\left\{ \frac{1}{2} \left(\frac{4}{\pi} \tanh \frac{\pi}{2} \right)^2 \left[(D/d)^2 - 1.0 \right] \right\}^2 + \frac{4}{9} \left[(D/d)^2 - 1.0 \right]}$$

(Ω) (3.2.6)

with a stated accuracy of about 1%.

REFERENCES

- [1] Liao, Samuel Y., *Microwave Circuit Analysis and Amplifier Design*, Prentice-Hall, Englewood Cliffs, NJ, 1987.
- [2] Wheeler, Harold A., "Transmission-Line Properties of a Round Wire in a Polygon Shield," *IEEE Transactions on Microwave Theory and Techniques*, Vol. MTT-27, No. 8, August 1979, pp. 717-721.

3.2.7 Strip-Centered Coaxial Line

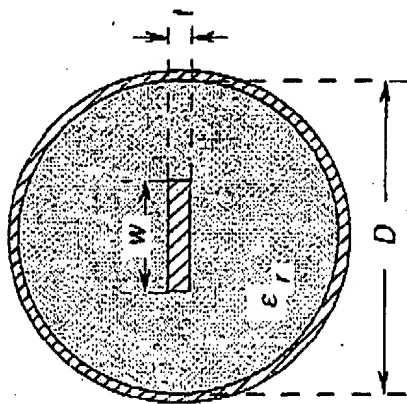


Figure 3.2.7.1: Strip-Centered Coaxial Cable

The configuration above is used to obtain lower loss by building a coaxial cable with a larger center conductor surface area. Bongianini [1] reports cables made with extremely fine dimensions—the center conductor was $150\text{ }\mu\text{m} \times 12.5\text{ }\mu\text{m}$. For $Z_0 \leq 30.0\text{ }\pi/\sqrt{\epsilon_r}$ (Ω):

$$Z_0 = \frac{15.0\pi^2}{\sqrt{\epsilon_r}} \frac{1.0}{\ln \left[\frac{2.0(D+w)}{D-w} \right]} \quad (\Omega) \quad (3.2.7.1)$$

For $Z_0 \geq 30.0\text{ }\pi/\sqrt{\epsilon_r}$ (Ω):

$$Z_0 = \frac{60.0}{\sqrt{\epsilon_r}} \ln \left(\frac{2.0D}{w} \right) \quad (\Omega) \quad (3.2.7.2)$$

There is a bit of a chicken-and-the-egg problem here because it is necessary to know Z_0 in order to choose the equation for Z_0 ; however, the two equations pass quite close and it is okay to use either to make the choice.

REFERENCES

- [1] Bongianini, Wayne L., *Proceedings of the IEEE*, Vol. 72, No. 12, December 1984, pp. 1810-1811.

- [2] Hilberg, Wolfgang, *Electrical Characteristics of Transmission Lines*, Artech House, Norwood, MA, 1979. (This is an excellent conformal mapping reference with many worked examples of the technique.)

3.3 PAIRED LINES

3.3.1 Parallel Wires

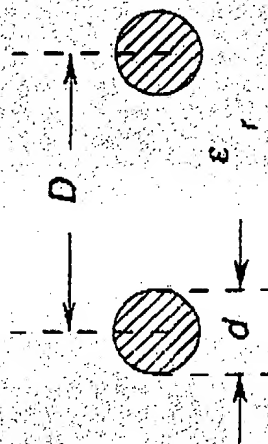


Figure 3.3.1.1: Parallel Wires

$$Z_0 = \frac{\eta_0}{\pi \sqrt{\epsilon_r}} \cosh^{-1} \left(\frac{D}{2r} \right) (\Omega) \quad (3.3.1.1)$$

or

$$Z_0 = \frac{\eta_0}{2.0 \pi \sqrt{\epsilon_r}} \cosh^{-1} \left(\frac{2.0 D^2 - d^2}{d^2} \right) (\Omega) \quad (3.3.1.2)$$

valid for

$$d/D \ll 1.0$$

The first reference is found in [4] and [5]. The second was derived with conformal mapping techniques in [2] with a stated accuracy of better than 0.24%. Green, *et al.* [1] gives the conductor losses as:

$$\alpha_c = \frac{P}{2.0 d} \sqrt{\frac{f \epsilon_r}{\sigma}} \quad (\text{nepers/cm}) \quad (3.3.1.3)$$

where

$$P = \frac{v}{\sqrt{v^2 - 1.0}} \quad (3.3.1.4)$$

$$v = \frac{D}{2} \quad (3.3.1.5)$$

and P is a proximity factor; the equation is valid for high frequencies.

REFERENCES

- [1] Green, E.I., *et al.*, "The Proportioning of Shielded Circuits for Minimum High-Frequency Attenuation," *The Bell System Technical Journal*, 1936, pp. 248-283.
- [2] Hilberg, Wolfgang, *Electrical Characteristics of Transmission Lines*, Artech House, Norwood, MA, 1979.
- [3] Liboff, Richard L., and G. Conrad Dalman, *Transmission Lines, Waveguides, and Smith Charts*, Macmillan Publishing Co., New York, 1985.
- [4] Ramo, Simon, and John R. Whinnery, *Fields and Waves in Modern Radio*, Wiley, London, 1944.
- [5] *Reference Data For Radio Engineers*, Howard W. Sams, Indianapolis, IN, 1982.

3.3.2 Unequal Size Parallel Wires

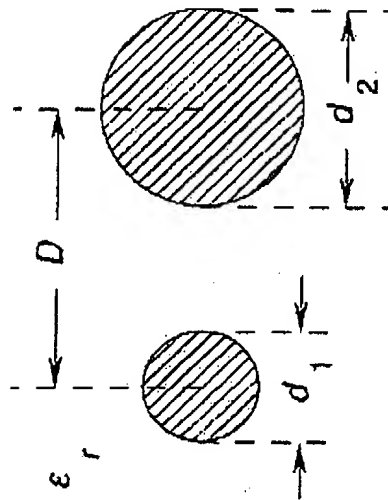


Figure 3.3.1.1: Unequal Size Parallel Wires

$$v = \frac{1}{4.0} \sqrt{4.0 D^2 - d_1^2 - d_2^2}$$

The stated accuracy [1] is better than 0.24%.

REFERENCES

- [1] Hilberg, Wolfgang, *Electrical Characteristics of Transmission Lines*, Artech House, Norwood, MA, 1979.

3.3.3 Twisted Pair

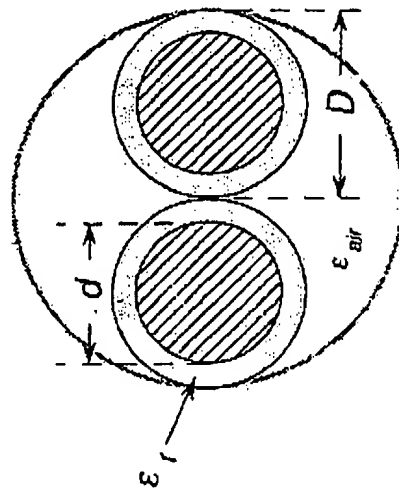


Figure 3.3.3.1: Twisted Pair

The twisted pair provides good low frequency shielding. Undesired signals tend to be coupled equally into each line of the pair. A differential receiver will therefore completely cancel the interference. Lefferson [3] gives design equations for this configuration:

$$Z_0 = \frac{\eta_0}{\pi \sqrt{\epsilon_{eff}}} \cosh^{-1} \left(\frac{D}{d} \right) \quad (\Omega) \quad (3.3.3.1)$$

$$\epsilon_{eff} = 1.0 + q (\epsilon_r - 1.0) \quad (3.3.3.2)$$

$$q = 0.25 + 0.0004 \theta \quad (3.3.3.3)$$

$$T = \frac{\tan \theta}{\pi D} = \text{twists per length} \quad (3.3.3.4)$$

or

$$\theta = \tan^{-1}(T \pi D) \quad (3.3.3.5)$$

where T and D have the same length units and θ is the pitch angle of the twist; the angle between the twisted pair's center line and the twist. It was found to be optimal for θ to be between 20 and 45°. Smaller angles make the twist loose and create problems in maintaining tolerances. Angles above approximately 50.5° break the wire. The value of q was determined by fitting a line to measurements of the effective dielectric constant.

For the softer insulation PTFE, a different equation should be used for q

$$q = 0.25 + 0.001 \theta \quad (3.3.3.6)$$

An equation for the wire's total length before twisting in terms of number of turns, N , is:

$$l = N \pi D \sqrt{1.0 + \frac{1.0}{\tan^2 \theta}} \quad (3.3.3.7)$$

Lefferson found these equations sufficiently accurate to design transmission lines with $VSWR \leq 1.1:1$.

In [2] a new analysis and experimental data are presented. The derived equations are

$$Z_0 = \sqrt{\frac{L}{C}} \quad (\Omega) \quad (3.3.3.8)$$

$$\epsilon_{eff} = \frac{C}{C_{air}}$$

where

$$L = \left(\frac{\mu_0}{\pi} \right) \cosh^{-1} \left(\frac{D}{d} \right) \quad (3.3.3.9)$$

$$C = C_1 + C_2 - C_3 \quad (3.3.3.10)$$

$$C_1 = \int_d^b \frac{\epsilon_0 dx}{D + (1.0 / \epsilon_r - 1.0) \sqrt{D^2 - x^2} - \sqrt{d^2 - x^2}} \quad (3.3.3.11)$$

$$C_2 = \frac{\pi \epsilon_0}{\ln D} \quad (3.3.3.12)$$

$$C_3 = \int_a^b \frac{\epsilon_0 dx}{D - \sqrt{d^2 - x^2}} \quad (3.3.3.13)$$

Calculate C_{ar} by replacing ϵ_r with ϵ_0 in the equations for C . The integrals are evaluated by the Romberg numerical technique. Accuracy was tested by comparison with measurements of the line impedance. The technique was found to be accurate within the tolerances of the measurement and the film thickness variations.

REFERENCES

- [1] Blood, Jr., William R., *Motorola MECL System Design Handbook*, 4th Ed.
- [2] Broxon, John H., and Douglas K. Linkhart, "Twisted-Wire Transmission Lines," *RF Design*, June 1990, pp. 73-76.
- [3] Loefferson, Peter, "Twisted Magnet Wire Transmission Line," *IEEE Transactions on Parts, Hybrids, and Packaging*, Vol. PHP-7, No. 4, December 1971, pp. 148-154, and errata.

3.3.4 Five-Wire Line

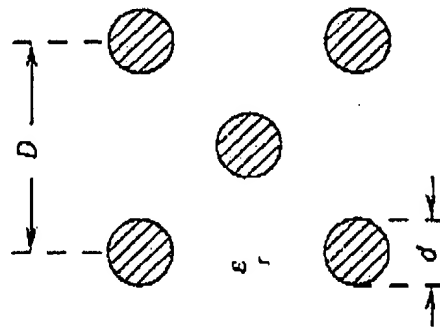


Figure 3.3.4.1: Five-Wire Line

$$Z_0 = \frac{2.5044 \eta_0}{\ln \left[\frac{D}{\pi a \alpha^{0.2}} \right]} \quad (\Omega) \quad (3.3.4)$$

where

$$d/D \ll 1.0$$

Of course, five conductors means lots of modes, so although the reference doesn't state it an assumption is that $(D - d)$ is small relative to a wavelength.

REFERENCES

- [1] *Reference Data For Radio Engineers*, Howard W. Sams, Indianapolis, IN, 1982.

3.3.5 Paired Strips

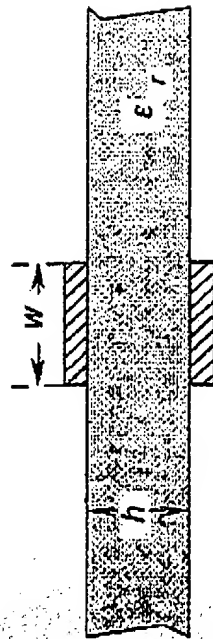


Figure 3.3.5.1: Paired Strips

For wide strips ($a/b > 1$):

$$Z_0 = \frac{\eta_0}{\sqrt{\epsilon_r}} \left\{ \frac{a}{b} + \frac{1.0}{\pi} \ln 4 + \frac{\epsilon_r + 1.0}{2\pi\epsilon_r} \ln \left[\frac{\pi\epsilon_r(a/b + 0.94)}{2.0} \right] \right. \quad (3.3.5.1)$$

$$\left. + \frac{\epsilon_r - 1.0}{2\pi\epsilon_r} \ln \frac{\epsilon_r \pi^2}{16.0} \right\}^{-1} \quad (\Omega)$$

Stated error is less than 1% for wide strips.

For narrow strips ($a/b < 1$):

$$Z_0 = \frac{\eta_0}{\pi \sqrt{\epsilon_r}} \left[\ln \frac{4.0b}{a} + \frac{1.0}{8.0} \left(\frac{a}{b} \right)^2 \right] - \frac{\epsilon_r - 1.0}{2.0(\epsilon_r + 1.0)} \left[\ln \frac{\pi}{2.0} + \frac{\ln \frac{4.0}{\pi}}{\epsilon_r} \right] \quad (\Omega) \quad (3.3.5.2)$$

where

$$b = h / 2.0 \quad (3.3.5.4)$$

Stated error is less than 1% for narrow strips.

Equations are valid for $2b$ much smaller than half a wavelength in the dielectric (λ_d).

REFERENCES

- [1] Champagne, Raymond, and Gralia Khoo, "Comments on 'Approximation for the Symmetrical Parallel-Strip Transmission Line,'" *IEEE Transactions on Microwave Theory and Techniques*, August 1976, Vol. MTT-24, No. 8, pp. 532-534. (Comments on inaccuracies in approximations of [2]. Makes suggestions for increased accuracy)
- [2] Rochelle, J.M., "Approximations for the Symmetrical Parallel-Strip Transmission Line," *IEEE Transactions on Microwave Theory and Techniques*, MTT-23, No. 8, August 1975, pp. 712-714.
- [3] Wheeler, Harold A., "Transmission-Line Properties of Parallel Wide Strips by a Conformal-Mapping Approximation," *IEEE Transactions on Microwave Theory and Techniques*, Vol. MTT-12, May 1964, pp. 280-289.
- [4] Wheeler, Harold A., "Transmission-Line Properties of Parallel Strips Separated by a Dielectric Sheet," *IEEE Transactions on Microwave Theory and Techniques*, MTT-13, No. 2, March 1965, pp. 172-185.

3.4 COPLANAR STRUCTURES

3.4.1 Coplanar Waveguide

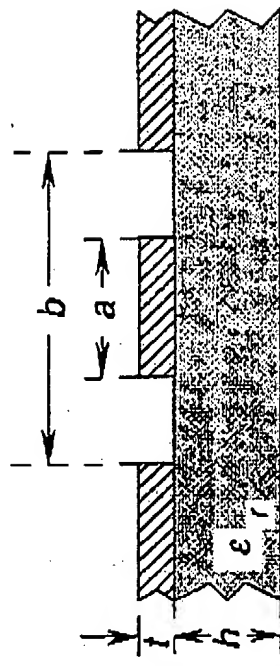


Figure 3.4.1.1: Coplanar Waveguide

The coplanar waveguide (CPW) configuration's advantages stem from its single-sided nature. Grounding components does not require plated through-holes to a plane on the other side of the substrate. This makes it ideal for use with surface mounted components. Another feature of coplanar waveguide is that we can narrow traces to match component lead widths while keeping Z_0 constant. The ground plane should extend greater than $5b$ on each side of the gap or the coplanar strip analysis should be used. The ground planes on either side of the center conductor may need to be connected periodically with wire jumpers depending on the frequency. The enclosure's cover can be used to jumper the two ground planes if it is kept away by at least $(b - a)$. To prevent propagation of higher modes, b should be less than $\lambda/2$.

The design equations for coplanar waveguide are:

$$Z_0 = \frac{30.0 \pi K(k_1)}{\sqrt{\epsilon_{eff}}} \frac{1}{K(k_1)} \quad (3.4.1.1)$$

$$\epsilon_{eff} = \epsilon_{eff} - \frac{\epsilon_r - 1.0}{0.7 \epsilon_r} \frac{K(k)}{K'(k)} + 1.0 \quad (3.4.1.2)$$

$$\epsilon_{eff} = 1.0 + \frac{\epsilon_r - 1.0}{2.0} \frac{K(k)K(k_1)}{K(k)K(k_1)} \quad (3.4.1.3)$$

$$k_t = \frac{a_t}{b_t} \quad k = \frac{a}{b} \quad (3.4.1.4)$$

$$k_t' = \sqrt{1.0 - k_t^2} \quad k' = \sqrt{1.0 - k^2} \quad (3.4.1.5)$$

$$k_1 = \frac{\sinh\left(\frac{\pi a_t}{4.0 h}\right)}{\sinh\left(\frac{\pi b_t}{4.0 h}\right)} \quad (3.4.1.6)$$

$$k_1' = \sqrt{1.0 - k_1^2} \quad (3.4.1.7)$$

$$a_t = a + \frac{1.25 t}{\pi} \left[1.0 + \ln \left(\frac{4.0 \pi a}{t} \right) \right] \quad (3.4.1.8)$$

$$b_t = b - \frac{1.25 t}{\pi} \left[1.0 + \ln \left(\frac{4.0 \pi a}{t} \right) \right] \quad (3.4.1.9)$$

These equations are corrected for thickness which is important for accurate results. The dielectric losses are described in [6, 11] by:

$$\alpha_d = \frac{q \epsilon_r \tan \delta}{\epsilon_{eff} \lambda_g} \quad (\text{Np/m}) \quad (3.4.1.10)$$

where q and λ_g have been previously defined.

The conductor losses are solved numerically and plotted in [6]. Jackson [9] reports that in some cases coplanar waveguide can have lower losses and dispersion than microstrip line for impedances near 50 Ω .

An equation for conductor losses [5] is:

$$\alpha_c = \frac{R_s \sqrt{\epsilon_{eff}} [\Phi(a) + \Phi(b)]}{480.0 \pi K(k) K(k')} \quad (\text{Np/m}) \quad (3.4.1.11)$$

where

$$R_s = \text{surface resistivity} = \sqrt{\pi f \mu_0 / \sigma} \quad (\Omega / \square) \quad (3.4.1.12)$$

$$\Phi(k) = \frac{\pi}{2} \ln \left[\frac{8.0 \pi x (1.0 - k)}{t (1.0 + k)} \right] \quad (3.4.1.13)$$

These equations are valid for

$$t \ll a$$

$$t \gg b - a$$

Radiation losses are

$$\alpha_r = \frac{\pi}{Q_{rad} \lambda_g} \quad (3.4.1.14)$$

$$Q_{rad} = \frac{K(k) K(k')}{\Psi(\epsilon_r, h, k_0, b) \Psi_{sc} \Psi_{oc}} \quad (3.4.1.15)$$

$$\Psi(\epsilon_r, h, k_0, b) = (\epsilon_r - 1.0) \left[1.0 + 0.5 (\epsilon_r - 1.0)^2 (k_0 h)^2 \right]$$

$$\times (k_0 h) (k_0 b)^2 \left[1.0 + 0.25 (\epsilon_r - 1.0)^2 (k_0 h)^2 \right]$$

$$\times \left\{ \frac{1.0}{\sqrt{\epsilon_{eff}} \left[1.0 + (\epsilon_r - 1.0)^2 (k_0 h)^2 \right]} \right\} \quad (3.4.1.16)$$

$$\Psi_{sc} = \frac{5.0 \pi}{8} \frac{1.0 + \left(1.0 - \frac{\pi^2}{8.0} \right) \left[1.0 + (\epsilon_r - 1.0)^2 (k_0 h)^2 / 4.0 \right]}{3.0 \epsilon_{eff}} \times \frac{\left[1.0 + (\epsilon_r - 1.0)^2 (k_0 h)^2 / 4.0 \right]}{\epsilon_{eff}} \quad (3.4.1.17)$$

$$\Psi_{oc} = \frac{\pi}{8} \frac{3.0 + \left(1.0 - \frac{\pi^2}{8.0} \right) \left[1.0 + (\epsilon_r - 1.0)^2 (k_0 h)^2 / 4.0 \right]}{\epsilon_{eff}} \quad (3.4.1.18)$$

These are valid for thin dielectric.

In Houdart [8, Figure 2], the effect of ground plane width (c in Figure 3.4.8.1) on the CPW is analyzed. For $c/b > 5.0$ the impedance is affected by less than about 3%.

3.4.1.1 Example: Hybrid IC Probe in Coplanar Waveguide

What are the required dimensions for a 50 Ω coplanar waveguide probe to a 10 mil \times

Solution: Assuming the probe is the same material as the hybrid IC substrate and using the above equations with

$$h = 0.0252 \text{ in} = 0.0640 \text{ cm}$$

$$a = 0.010 \text{ in} = 0.0254 \text{ cm}$$

$$t = 0.001 \text{ in} = 0.003 \text{ cm}$$

$$\epsilon_r = 10.0$$

The program iteratively adjusts b until the goal impedance 50Ω is achieved. The final dimension of the probe is:

$$b = 0.0234 \text{ in.} = 0.615 \text{ cm}$$

REFERENCES:

- [1] Bachert, Peter S., "A Coplanar Waveguide Primer," *RF Design*, July 1988, pp. 52-57, and errata.
- [2] Bahl, Indar, and Prakash Bharia, *Microwave Solid State Circuit Design*, Wiley, New York, 1988.
- [3] Bellantoni, J.V., and R.C. Compton, "A New Coplanar Waveguide Vector Network Analyzer for On Wafer Measurements," *Proceedings of Cornell/IEEE Conference on Advanced Concepts in High Speed Semiconductor Development and Circuits*, Ithaca, NY, 1989, pp. 201-207.
- [4] Davis, M.E., et al., "Finite-Boundary Corrections to the Coplanar Waveguide Analysis," *IEEE Transactions on Microwave Theory and Techniques*, Vol. 21, No. 9, September 1973, pp. 594-596.
- [5] Ghione, Giovanni, et al., "Q-factor evaluation for coplanar resonators," *Alta Frequenza*, Vol. LII, No. 3, May-June 1983, pp. 191-193.
- [6] Gopinath, A., "Losses in Coplanar Waveguides," *IEEE Transactions on Microwave Theory and Techniques*, Vol. MTT-30, No. 7, July 1982, pp. 1101-1104.
- [7] Gupta, K. C., Ramesh Garg, and Rakesh Chadha, *Computer-Aided Design of Microwave Circuits*, Artech House, Norwood, MA, 1981.
- [8] Houdart, M., "Coplanar Lines: Application to Broadband Microwave Integrated Circuits," *6th European Microwave Conference Proceedings*, 1976, pp. 49-53.
- [9] Jackson, R.W., "Coplanar Waveguide vs. Microstrip for Millimeter Wave Integrated Circuits," *1986 IEEE MTT-S International Microwave Symposium*

- [10] Kitazawa, T., et al., "A Coplanar Waveguide with Thick Metal-Coating," *IEEE Transactions on Microwave Theory and Techniques*, Vol. 24, No. 9, September 1976, pp. 604-608.
- [11] Kitazawa, T., and Y. Hayashi, "Quasistatic Characteristics of a Coplanar Waveguide with Thick Metal Coating," *IEEE Proceedings*, Vol. 133, Pt. H, No. 1, February 1986, pp. 18-20.
- [12] Koshiji, Kohji, et al., "Simplified Computation of Coplanar Waveguide with Finite Conductor Thickness," *IEEE Proceedings*, Vol. 130, Pt. H, No. 5, August 1983, pp. 315-321.
- [13] Riazat, Majid, et al., "Propagation Modes and Dispersion Characteristics of Coplanar Waveguides," *IEEE Transactions on Microwave Theory and Techniques*, Vol. MTT-38, No. 3, March 1990, pp. 245-251.
- [14] Shibata, Tsugumichi, "Characterization of MIS Structure Coplanar Transmission Lines for Investigation of Signal Propagation in Integrated Circuits," *IEEE Transactions on Microwave Theory and Techniques*, Vol. MTT-38, No. 7, July 1990, pp. 881-890.
- [15] Veyres, C., and V. Fouad Hanna, "Extension of the Application of Conformal Mapping Techniques to Coplanar Lines with Finite Dimensions," *International Journal of Electronics*, Vol. 48, No. 1, 1980, pp. 47-56.
- [16] Wen, Cheng P., "Coplanar Waveguide: A Surface Strip Transmission Line Suitable for Nonreciprocal Gyromagnetic Device Applications," *IEEE Transactions on Microwave Theory and Techniques*, MTT-17, No. 12, December 1969, pp. 1087-1090.

3.4.2 Micro-Coplanar Stripline

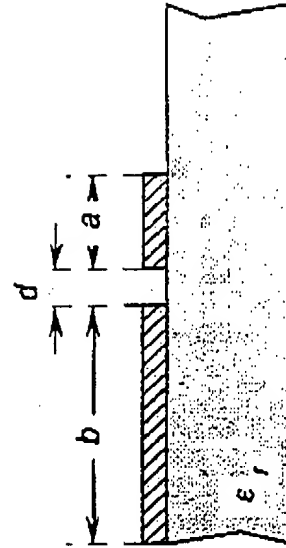


Figure 3.4.2.1: Micro-Coplanar Stripline

This structure has been called nonsymmetrical coplanar waveguide; however, to avoid confusion we prefer to reserve this term for coplanar waveguide having unequal gaps.

Kneppo and Goltzman [2] proposed this structure as an improvement over CPW for the connection of shunt elements. Their equations were derived with conformal transformation:

$$Z_0 = \frac{\eta_0}{(\sqrt{\epsilon_1} + \sqrt{\epsilon_2})} \frac{K(k)}{K'(k)} \quad (\Omega) \quad (3.4.2.1)$$

$$\epsilon_{eff} = \frac{(\sqrt{\epsilon_1} + \sqrt{\epsilon_2})^2}{4.0} \quad (3.4.2.2)$$

where

$$k = \sqrt{\frac{1.0 + a/d + b/d}{(1.0 + b/d)(1.0 + a/d)}} \quad (3.4.2.3)$$

Polynomial equations for the line width, ϵ_{eff} , and conductor losses are given in Quian and Yamashita [3] for dielectrics with $\epsilon_r = 2.22, 9.7, 10.1$, and 12.9 and in Yamashita *et al.* [4] for $\epsilon_r = 12.7$.

Losses may be calculated with the incremental inductance rule.

REFERENCES:

- [1] Fang, J., *et al.*, "Dispersion Characteristics of Microstrip Lines in the Vicinity of a Coplanar Ground," *Electronics Letters*, Vol. 23, No. 21, October 8, 1987, pp. 1142-1143.
- [2] Kneppo, Ivan and Jozef Goltzman, "Basic Parameters of Nonsymmetrical Coplanar Line," *IEEE Transactions on Microwave Theory and Techniques*, Vol. MTT-25, No. 8, August 1977, p. 718.
- [3] Quian, Yongxi, and Eikichi Yamashita, "Additional Approximate Formulas and Experimental Data on Micro-Coplanar Striplines," *IEEE Transactions on Microwave Theory and Techniques*, Vol. MTT-38, No. 4, April 1990, pp. 443-445.
- [4] Yamashita, Eikichi, *et al.*, "Characterization Method and Design Formulas of MCS Lines Proposed for MMIC's," 1987 *IEEE MTT-S Symposium Digest*, pp. 685-688.

3.4.3 Coplanar Waveguide with Ground

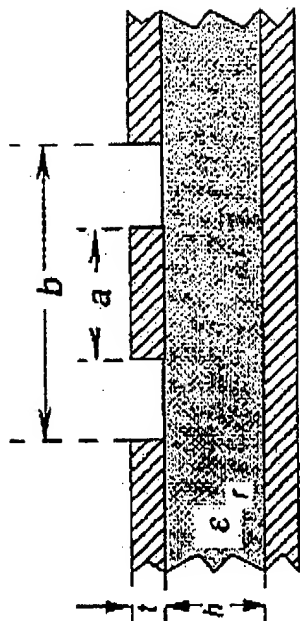


Figure 3.4.3.1: Coplanar Waveguide with Ground

The equations of this section can be used to analyze coplanar waveguide with ground or for microstrip lines with signal side ground plane.

$$Z_0 = \frac{60.0 \pi}{\sqrt{\epsilon_{eff}}} \frac{1.0}{\frac{K(k)}{K'(k)} + \frac{K(k_1)}{K'(k_1)}} \quad (3.4.3.1)$$

$$k = a/b \quad (3.4.3.2)$$

$$k' = \sqrt{1.0 - k^2} \quad (3.4.3.3)$$

$$k_1' = \sqrt{1.0 - k_1^2} \quad (3.4.3.4)$$

$$k_1 = \frac{\tanh\left(\frac{\pi a}{4.0 h}\right)}{\tanh\left(\frac{\pi b}{4.0 h}\right)} \quad (3.4.3.5)$$

$$\epsilon_{eff} = \frac{1.0 + e, \frac{K(k')}{K(k)} \frac{K(k_1)}{K(k_1')}}{1.0 + \frac{K(k')}{K(k)} \frac{K(k_1)}{K(k_1')}} \quad (3.4.3.6)$$

The notation varies between references. Some use the a, b notation of Figure 3.4.2.1 or a $2a$ and $2b$ version while others use s (spacing to the adjacent ground) and w (trace width).

These equations "show good agreement" with spectral-domain variational calculation techniques.

The structure may propagate in three different modes: microstrip, coplanar waveguide, and coupled slotlines. To prevent slotline modes, jumpers connecting the two halves of the component side ground plane can be used. To avoid microstrip line modes, it is recommended [2] that $h \gg b$ and that the component side ground extend away from the trace on each side more than b .

REFERENCES:

- [1] Ghione, G., and C. Naldi, "Parameters of Coplanar Waveguide with Lower Ground Plane," *Electronics Letters*, Vol. 19, No. 18, September 1, 1983, pp. 734-735. (Error in equation for k_1 , p. 735, corrected above.)
- [2] Riazat, M., et al., "Single-Mode Operation of Coplanar Waveguides," *Electronics Letters*, Vol. 23, No. 24, November 19, 1987, pp. 1281-1283.
- [3] Singh, Donald R., and Keith S. Champlin, "Coplanar Schottky Waveguides for Microwave Phase Shifting, Attenuation and Harmonic Generation," *Circuits and Systems Symposium Digest*, 1990, pp. 3073-3076.

3.4.4 Shielded Coplanar Waveguide

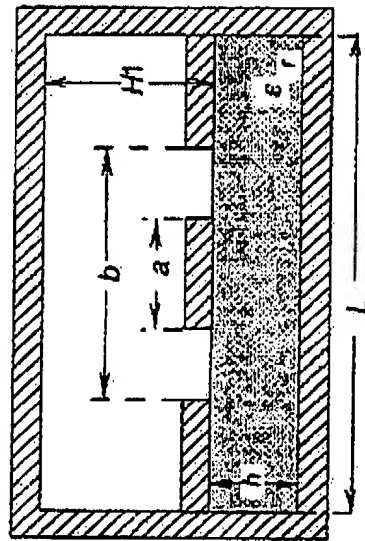


Figure 3.4.4.1: Shielded Coplanar Waveguide

The formulas below allow calculation of coplanar waveguide including the shield's effects [1, 2]. Many times we are simply looking for guidelines on how not to be affected by the shield's presence. For $L/b \geq 1.75$, and $H_1/a \geq 2.50$, Z_0 is affected less than 1.5% by the shield's presence.

The equations of [2] assume H_1 is infinite and are:

$$Z_0 = \frac{1.0}{Z_m (1.0 + 5.0 q)} + \frac{1.0}{Z_c (1.0 + q)} \quad (3.4.4.1)$$

$$q = \frac{a}{h} \left(\frac{b}{a} - 1.0 \right) \left[3.6 - 2 e^{-(\epsilon_r + 1.0) / 4.0} \right] \quad (3.4.4.2)$$

$$Z_c = \text{coplanar waveguide impedance} \quad (3.4.4.3)$$

$$Z_m = \text{microstrip impedance} \quad (3.4.4.4)$$

Use the equations given in the coplanar waveguide and microstrip line sections together with the relevant dimensions to calculate Z_c and Z_m . Accuracy is within 2% of numerical results.

REFERENCES

- [1] Leong, M.S., P.S. Kooi, and A.L. Satya Prakash, "Effect of a Conducting Enclosure on the Characteristic Impedance of Coplanar Waveguides," *Microwave Journal*, August 1986, pp. 105-108.
- [2] Rowe, David A., and Binneg Y. Lao, "Numerical Analysis of Shielded Coplanar Waveguides," *IEEE Transactions on Microwave Theory and Techniques*, Vol. MTT-31, No. 11, November 1983, pp. 911-915.

3.4.5 Asymmetric Coplanar Waveguide

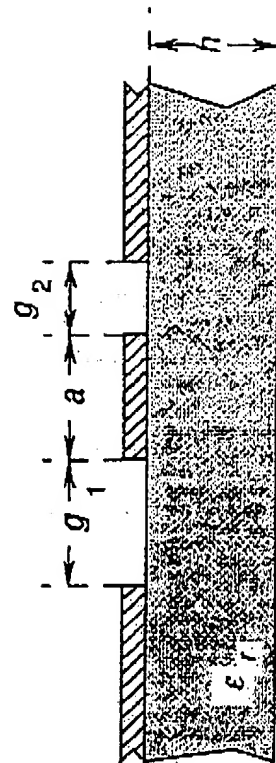


Figure 3.4.5.1: Asymmetric Coplanar Waveguide

The asymmetric coplanar waveguide structure can be used to reduce the line impedance of symmetric coplanar waveguide or to analyze the effects of fabrication tolerances. The equations of Hanna and Thebaul [1, 2] derived with conformal mapping are

$$Z_0 = \frac{30.0 \pi}{\sqrt{\epsilon_{eff}}} \frac{K'(k_1)}{K(k_1)} \quad (3.4.5.1)$$

$$\epsilon_{eff} = 1.0 + \frac{\epsilon_r - 1.0}{2.0} \frac{K(k_2)}{K'(k_2)} \frac{K'(k_1)}{K(k_1)} \quad (3.4.5.2)$$

where

$$k_1 = \frac{0.5 b [1.0 + \alpha (0.5 b + d_1)]}{0.5 b + d_1 + \alpha \sqrt{0.5 b}} \quad (3.4.5.3)$$

$$k_2 = \frac{w_A (1.0 + \alpha_1 w_B)}{w_B + \alpha_1 w_A^2} \quad (3.4.5.4)$$

and

$$w_A = \sinh \left(\frac{\pi a}{4.0 h} \right) \quad (3.4.5.5)$$

$$w_B = \sinh \left[\frac{\pi (a / 2.0 + g_1)}{2.0 h} \right] \quad (3.4.5.6)$$

$$w_G = -\sinh \left[\frac{\pi (a / 2.0 + g_2)}{2.0 h} \right] \quad (3.4.5.7)$$

$$\alpha = \frac{d_1 d_2 + 0.5 b (d_1 + d_2) \pm \sqrt{d_1 d_2 (b + d_1) (b + d_2)}}{\sqrt{0.5 b} (d_1 - d_2)} \quad (3.4.5.8)$$

$$\alpha_1 = \left(\frac{1.0}{w_B + w_E} \right) \left[-1.0 - \frac{w_B w_E}{w_A^2} \pm \sqrt{\left(\frac{w_B^2}{w_A^2} - 1.0 \right) \left(\frac{w_E^2}{w_A^2} - 1.0 \right)} \right] \quad (3.4.5.9)$$

The equations assume that the traces have negligible thickness. Comparison of the equations to experimental data showed agreement to within 4% for Z_0 . Choose the "+" sign solution of Equations (3.4.5.8) and (3.4.5.9).

Graphs of the dispersion of this structure are available in [3].

REFERENCES

- [1] Hanna, Victor Fouad, and Dominique Thebaud, "Theoretical and Experimental Investigation of Asymmetric Coplanar Waveguides," 1984 IEEE MTT-S Symposium Digest, pp. 469-471.
- [2] Hanna, V. Fouad, and D. Thebaud, "Analysis of Asymmetrical Coplanar Waveguides," *International Journal of Electronics*, Vol. 50, No. 3, 1981, pp. 221-224.
- [2] Kitinski, M., and B. Janiczak, "Dispersion Characteristics of Asymmetric Coupled Slot Lines on Dielectric Substrates," *Electronics Letters*, Vol. 19, No. 3, February 1983, pp. 91-92.

3.4.6 Coplanar Strips

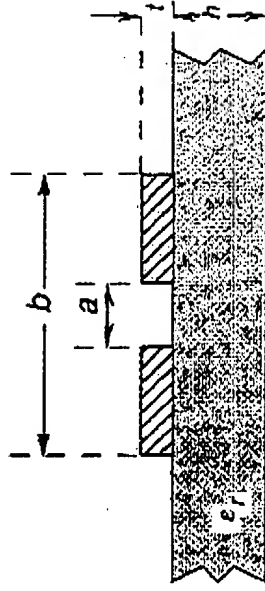


Figure 3.4.6.1: Coplanar Strips

The coplanar strips structure is similar to paired wire transmission line structures. Note also that coplanar strips are the complementary structure to coplanar waveguide.

$$Z_0 = \frac{70}{\sqrt{\epsilon_{eff}}} \frac{K(k)}{K'(k)} \quad (3.4.6.1)$$

$$\epsilon_{eff} = 1 + \frac{\epsilon_r - 1}{2} \frac{K(k')}{K(k)} \frac{K(k_1)}{K(k_1')} \quad (3.4.6.2)$$

$$k = \frac{a}{b} \quad (3.4.6.3)$$

$$k' = \sqrt{1.0 - k^2} \quad (3.4.6.4)$$

$$k_1' = \sqrt{1.0 - k_1^2} \quad (3.4.6.5)$$

$$k_1 = \frac{\sinh\left(\frac{\pi a}{4h}\right)}{\sinh\left(\frac{\pi b}{4h}\right)} \quad (3.4.6.6)$$

Losses for this structure are [4]

$$\alpha_c = 17.34 \frac{R_s}{Z_0 \pi a} \frac{P'}{\pi a} \left(1.0 + \frac{b-a}{2.0a}\right) \times \left(\frac{1.25}{\pi} \ln \frac{4.0 \pi (b-a)}{2.0 t} + 1.0 + \frac{2.5 t}{\pi (b-a)} \right) \times \left(\frac{1.0 + \frac{b-a}{a} + \frac{1.25 t}{\pi a} \left[1.0 + \ln \frac{2.0 \pi (b-a)}{t} \right]^2 \right)^2 \quad (\text{dB/m}) \quad (3.4.6.7)$$

$$\alpha_d = \frac{20 \pi}{\ln(10)} \frac{\epsilon_r}{\sqrt{\epsilon_{eff}}} \frac{q \tan \delta}{\lambda_0} \quad (\text{dB/unit length}) \quad (3.4.6.8)$$

for $0 \leq k \leq 0.707$

$$P' = \frac{k}{k^{3/2} (1.0 - k')} \left[\frac{K(k)}{K(k')} \right] \quad (3.4.6.9)$$

for $0.707 \leq k \leq 1.0$

$$P' = \frac{1.0}{\sqrt{k} (1.0 - k)} \quad (3.4.6.10)$$

Pintzos [7] gives plots of the dispersion characteristics of this line.

REFERENCES

- [1] Bahl, Indar, and Prakash Bhartia, *Microwave Solid State Circuit Design*, John Wiley and Sons, New York, 1988. (A typo in the denominator of k_1 was corrected above.)
- [2] Ghione, G., and C. Naldi, "Analytical Formulas for Coplanar Lines in Hybrid and Monolithic MICs," *Electronics Letters*, Vol. 20, No. 4, February 16, 1984, pp. 179-181. (Compares accuracy of various formulas, pointing out that some are incorrect.)

- [3] Ghione, Giovanni, et al., "Q-factor evaluation for coplanar resonators," *Alta Frequenza*, Vol. LII, No. 3, May-June 1983, pp. 191-193.
- [4] Gupta, K. C., Ramesh Garg, and Rakesh Chadha, *Computer-Aided Design of Microwave Circuits*, Artech House, Norwood, MA, 1981.
- [5] Hanna, Y. Fouad, "Finite Boundary Corrections to Coplanar Stripline Analysis," *Electronics Letters*, July 17, 1980, Vol. 16, No. 15, pp. 604-605.
- [6] Knorr, Jeffrey B., and Klaus-Dieter Kuchler, "Analysis of Coupled Slots and Coplanar Strips on Dielectric Substrate," *IEEE Transactions on Microwave Theory and Techniques*, Vol. MTT-23, No. 7, July 1975, pp. 541-548.
- [7] Pintzos, Sotirios G., "Full-Wave Spectral-Domain Analysis of Coplanar Strips," *IEEE Transactions on Microwave Theory and Techniques*, Vol. MTT-39, No. 2, February 1991, pp. 239-246.

3.4.7 Asymmetrical Coplanar Strips

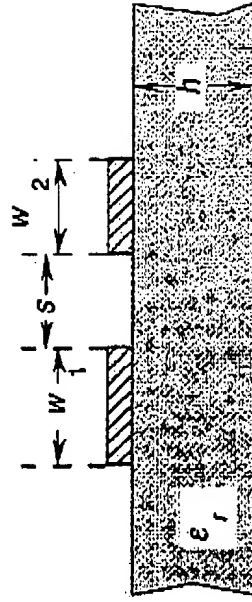


Figure 3.4.7.1: Asymmetrical Coplanar Strips

Hoffman [2] solves the equations for this structure from those of the infinitely thick dielectric structure. His equations are

$$Z_0 = \frac{\eta_0}{2.0 \sqrt{\epsilon_{eff}}} \frac{K(k)}{K(k')} \quad (\Omega) \quad (3.4.7.1)$$

$$\epsilon_{eff} = 1.0 - \frac{(\epsilon_r - 1.0) K(k_1) K(k)}{2.0 K(k_1') K(k')} \quad (3.4.7.2)$$

where

$$k = \sqrt{\frac{\epsilon}{\epsilon_r}} \sqrt{1.0 + \frac{b}{a} - \frac{\epsilon}{\epsilon_r}} \quad (3.4.7.3)$$

$$k_1 = \sqrt{\frac{(t_1 - t_2)(t_3 - t_2)}{(t_1 + t_2)(t_3 + t_2)}} \quad (3.4.7.4)$$

$$t_n = \frac{\lambda_n}{e} - 1.0, \quad n = 1, 2, 3 \quad (3.4.7.5)$$

$$\lambda_1 = \frac{\pi}{2.0} \left(\frac{2.0 w_2}{h} + \frac{s}{h} \right) \quad (3.4.7.6)$$

$$\lambda_2 = \frac{\pi s}{2.0 h} \quad (3.4.7.7)$$

$$\lambda_3 = \frac{\pi}{2.0} \left(\frac{2.0 w_1}{h} + \frac{s}{h} \right) \quad (3.4.7.8)$$

$$k_1' = \sqrt{1.0 - k_1^2} \quad (3.4.7.9)$$

$$k' = \sqrt{1.0 - k^2} \quad (3.4.7.10)$$

$$b = w_2 + s \quad (3.4.7.11)$$

$$d = w_1 + s \quad (3.4.7.12)$$

REFERENCES

- [1] Gevorgian, S.S., and I.G. Mironenko, "Asymmetric Coplanar-Strip Transmission Lines for MMIC and Integrated Optic Applications," *Electronic Letters*, Vol. 26, No. 22, October 25, 1990, pp. 1916-1918.
- [2] Hoffman, Reinmut, *Handbook of Microwave Integrated Circuits*, Artech House, Norwood, MA, 1987.

3.4.8 Three Coplanar Strips

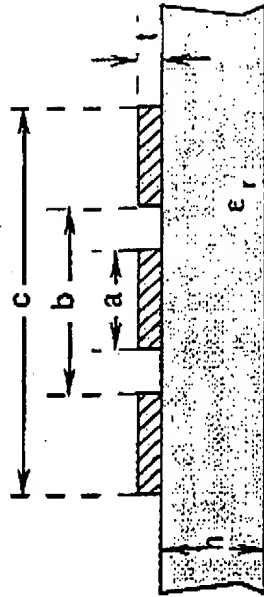


Figure 3.4.8.1: Three Coplanar Strips

This configuration was derived in [4] to analyze and design a tape automated bonding (TAB) IC package with alternate traces grounded.

$$Z_0 = \frac{\eta_0}{4.0 \sqrt{\epsilon_{eff}}} \frac{K(k_1)}{K(k_1')} \quad (\Omega) \quad (3.4.8.1)$$

where

$$\epsilon_{eff} = 1.0 + \frac{\epsilon_r - 1.0}{2.0} \frac{K(k_2')}{K(k_2)} \frac{K(k_1)}{K(k_1')}$$

$$+ \frac{\epsilon_r - 1.0}{2.0} \frac{K(k_2')}{K(k_2)} \left[\frac{K(k_1')^2}{(b-a)} + \frac{2.0}{b-a} \frac{K(k_1)}{K(k_1')} + \left[\frac{c}{b-a} \frac{K(k_1)}{K(k_1')} \right]^2 \right] \quad (3.4.8.2)$$

$$k_1 = \frac{c}{b} \sqrt{\frac{b^2 - a^2}{c^2 - a^2}} \quad (3.4.8.3)$$

$$k_2 = \frac{\sinh\left(\frac{\pi c}{4.0 h}\right)}{\sinh\left(\frac{\pi b}{4.0 h}\right)} \sqrt{\frac{\sinh^2\left(\frac{\pi b}{4.0 h}\right) - \sinh^2\left(\frac{\pi a}{4.0 h}\right)}{\sinh^2\left(\frac{\pi c}{4.0 h}\right) - \sinh^2\left(\frac{\pi a}{4.0 h}\right)}} \quad (3.4.8.4)$$

$$k_2' = \sqrt{1 - k_2^2} \quad n = 1, 2 \quad (3.4.8.5)$$

In Houdart [3, Figure 2], the effect of ground plane width (c in Figure 3.4.8.1) on the CPW is analyzed. For $c/b > 5.0$ the impedance is affected by less than about 3%.

REFERENCES

- [1] Ghione, Giovanni, and Carlo U. Naldi, "Coplanar Waveguides for MMIC Applications: Effect of Upper Shielding Conductor Backing, Finite-Extent Ground Planes, and Line-to-Line Coupling," *IEEE Transactions on Microwave Theory and Techniques*, Vol. MTT-35, No. 3, March 1987, pp. 260-267.
- [2] Herrel, Dennis, and David Carey, "High-Frequency Performance of TAB," *IEEE Transactions on Components, Hybrids, and Manufacturing Technology*, Vol. CHMT-10, No. 2, June 1987, pp. 199-203.
- [3] Houdart, M., "Coplanar Lines: Application to Broadband Microwave Integrated Circuits," *6th European Microwave Conference Proceedings 1976*, Rome, Italy, pp. 49-53.
- [4] Mueller, E., "Measurement of the Effective Relative Permittivity of Unshielded Coplanar Waveguides," *Electronics Letters*, Vol. 13, No. 24, November 24, 1977, pp. 729-730.
- [5] Wentworth, Stuart M., et al., "The High-Frequency Characteristics of Tape Automated Bonding (TAB) Interconnects," *IEEE Transactions on Components, Hybrids, and Manufacturing Technology*, Vol. CHMT-122, No. 3, September 1989, pp. 340-347.

3.4.9 Three Coplanar Strips with Ground

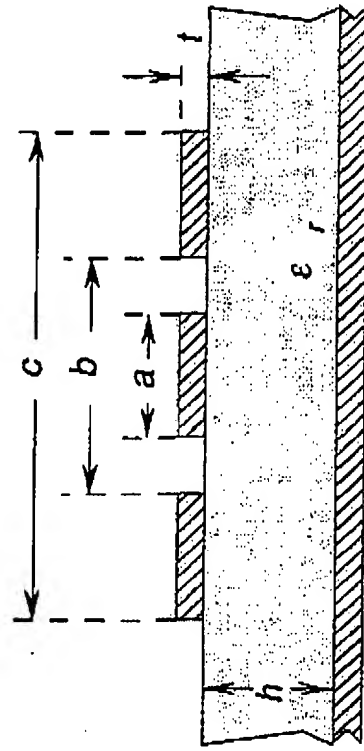


Figure 3.4.9.1: Three Coplanar Strips With Ground

This configuration was derived in [1] to analyze and design a tape automated bonding structure where alternate traces are grounded and are connected to a ground layer with vias.

$$Z_0 = \frac{\eta_0}{2.0 \sqrt{\epsilon_{eff}}} \frac{1.0}{\frac{K(k_1)}{K(k_2)} + \frac{2.0 t}{(b-a)}} \quad (3.4.9.1)$$

where

$$\epsilon_{eff} = \frac{\frac{K(k_1)}{K(k_2)} + \frac{\epsilon_r K(k_2)}{K(k_1)} + \frac{2.0 t}{b-a}}{\frac{K(k_1)}{K(k_2)} + \frac{K(k_2)}{K(k_1)} + \frac{2.0 t}{(b-a)}} \quad (3.4.9.2)$$

$$k_1 = \frac{c}{b} \sqrt{\frac{b^2 - a^2}{c^2 - a^2}} \quad (3.4.9.3)$$

$$k_2 = \frac{\tanh\left(\frac{\pi a}{4.0 h}\right)}{\tanh\left(\frac{\pi b}{4.0 h}\right)} \quad (3.4.9.4)$$

$$k_n' = \sqrt{1.0 - k_n^2}, n = 1, 2 \quad (3.4.9.5)$$

REFERENCES

- [1] Wentworth, Stuart M., et al., "The High-Frequency Characteristics of Tape Automated Bonding (TAB) Interconnects," *IEEE Transactions on Components, Hybrids, and Manufacturing Technology*, Vol. CHMT-122, No. 3, September 1989, pp. 340-347.

3.4.10 Covered Coplanar Waveguide with Ground

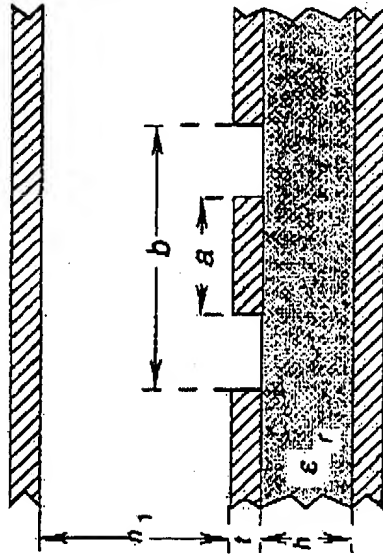


Figure 3.4.10: Covered Coplanar Waveguide with Ground

The equations describing this structure are

$$Z_0 = \frac{70}{2.0} \frac{1.0}{\sqrt{\epsilon_{eff}}} \frac{K(k_3)}{K(k'_3)} + \frac{K(k_4)}{K(k'_4)} \quad (3.4.10.1)$$

$$\epsilon_{eff} = 1.0 + \frac{\frac{K(k_3)}{K(k'_3)}}{\frac{K(k_3)}{K(k'_3)} + \frac{K(k_4)}{K(k'_4)}} (\epsilon_r - 1.0) \quad (3.4.10.2)$$

where

$$k_3 = \frac{\tanh\left(\frac{\pi a}{h}\right)}{\tanh\left(\frac{\pi b}{h}\right)} \quad (3.4.10.3)$$

$$k_4 = \frac{\tanh\left(\frac{\pi a}{h_1}\right)}{\tanh\left(\frac{\pi b}{h_1}\right)} \quad (3.4.10.4)$$

which are strictly valid for

and were found to give good results elsewhere.

REFERENCES

- [1] Ghione, Giovanni, and Carlo U. Naldi, "Coplanar Waveguides for MMIC Applications: Effect of Upper Shielding Conductor Backing, Finite-Extent Ground Planes, and Line-to-Line Coupling," *IEEE Transactions on Microwave Theory and Techniques*, Vol. MTT-35, No. 3, March 1987, pp. 260-267.

3.4.11 Covered Coplanar Waveguide

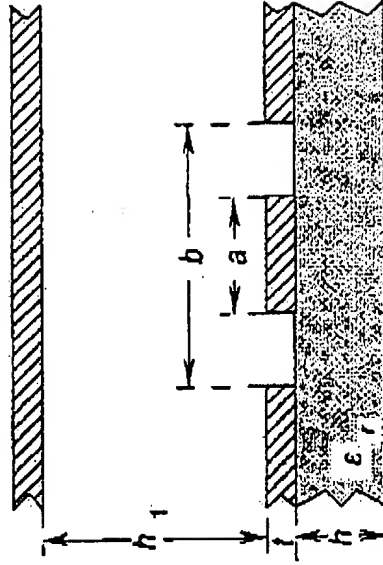


Figure 3.4.11.1: Covered Coplanar Waveguide

The equations of Ghione and Naldi [1] are

$$Z_0 = \frac{70}{2.0} \frac{1.0}{\sqrt{\epsilon_{eff}}} \frac{K(k)}{K(k')} + \frac{K(k)}{K(k')} \quad (3.4.11.1)$$

$$\epsilon_{eff} = 1.0 + \frac{\frac{K(k_1)}{K(k'_1)}}{\frac{K(k_1)}{K(k'_1)} + \frac{K(k)}{K(k')}} (\epsilon_r - 1.0) \quad (3.4.11.2)$$

where

$$k = a/b \quad (3.4.11.3)$$

CARD NO: 03238

U.S. Patent Application Docket No: 011070
Serial No: NEW Filed: 08/28/01
Patent Number: Issued:
Applicant(s): YONENAGA, KAZUSHIGE ET AL

Papers filed herewith on: 08/28/01

New Application
Drawings

Priority Document

Other: New Appln-35pgs; Drwgs-23sheets; Pre-Amend;
IDS/1449 w/3 refs; 1 cert.pridoc



COMMISSIONER OF PATENTS

Receipt is hereby acknowledged of the papers filed as indicated
in connection with the above-identified case.

MRQ/YAP

**This Page is Inserted by IFW Indexing and Scanning
Operations and is not part of the Official Record**

BEST AVAILABLE IMAGES

Defective images within this document are accurate representations of the original documents submitted by the applicant.

Defects in the images include but are not limited to the items checked:

- ☐ **BLACK BORDERS**
- ☐ **IMAGE CUT OFF AT TOP, BOTTOM OR SIDES**
- ☐ **FADED TEXT OR DRAWING**
- ☐ **BLURRED OR ILLEGIBLE TEXT OR DRAWING**
- ☐ **SKEWED/SLANTED IMAGES**
- ☐ **COLOR OR BLACK AND WHITE PHOTOGRAPHS**
- ☐ **GRAY SCALE DOCUMENTS**
- ☒ **LINES OR MARKS ON ORIGINAL DOCUMENT**
- ☐ **REFERENCE(S) OR EXHIBIT(S) SUBMITTED ARE POOR QUALITY**
- ☐ **OTHER:** _____

IMAGES ARE BEST AVAILABLE COPY.

As rescanning these documents will not correct the image problems checked, please do not report these problems to the IFW Image Problem Mailbox.